

Section 18 Electrical Characteristics

18.1 Absolute Maximum Ratings

Table 18-1 lists the absolute maximum ratings.

Table 18-1 Absolute Maximum Ratings

—Preliminary—

Item	Symbol	Value	Unit
Power supply voltage	V_{CC}	-0.3 to +7.0	V
Input voltage (except port 7)	V_{in}	-0.3 to $V_{CC} + 0.3$	V
Input voltage (port 7)	V_{in}	-0.3 to $AV_{CC} + 0.3$	V
Reference voltage	V_{REF}	-0.3 to $AV_{CC} + 0.3$	V
Analog power supply voltage	AV_{CC}	-0.3 to +7.0	V
Analog input voltage	V_{AN}	-0.3 to $AV_{CC} + 0.3$	V
Operating temperature	T_{opr}	Regular specifications: -20 to +75 Wide-range specifications: -40 to +85	°C
Storage temperature	T_{stg}	-55 to +125	°C

Caution: Permanent damage to the chip may result if absolute maximum ratings are exceeded.

18.2 Electrical Characteristics

18.2.1 DC Characteristics

Table 18-2 lists the DC characteristics. Table 18-3 lists the permissible output currents.

Table 18-2 DC Characteristics

Conditions: $V_{CC} = 5.0 \text{ V} \pm 10\%$, $AV_{CC} = 5.0 \text{ V} \pm 10\%$, $V_{REF} = 4.5 \text{ V}$ to AV_{CC} ,
 $V_{SS} = AV_{SS} = 0 \text{ V}^*$, $T_a = -20^\circ\text{C}$ to $+75^\circ\text{C}$ (regular specifications),
 $T_a = -40^\circ\text{C}$ to $+85^\circ\text{C}$ (wide-range specifications)

Item		Symbol	Min	Typ	Max	Unit	Test Conditions
Schmitt trigger input voltages	Port A, P8 ₀ to P8 ₂ , PB ₀ to PB ₃	V_T^-	1.0	—	—	V	
		V_T^+	—	—	$V_{CC} \times 0.7$	V	
		$V_T^+ - V_T^-$	0.4	—	—	V	
Input high voltage	RES, STBY, NMI, MD ₂ to MD ₀	V_{IH}	$V_{CC} - 0.7$	—	$V_{CC} + 0.3$	V	
	EXTAL		$V_{CC} \times 0.7$	—	$V_{CC} + 0.3$	V	
	Port 7		2.0	—	$AV_{CC} + 0.3 \text{ V}$		
	Ports 4, 6, 9, P8 ₃ , P8 ₄ , PB ₄ to PB ₇ , D ₁₅ to D ₈		2.0	—	$V_{CC} + 0.3$	V	
Input low voltage	RES, STBY, MD ₂ to MD ₀	V_{IL}	-0.3	—	0.5	V	
	NMI, EXTAL, ports 4, 6, 7, 9, P8 ₃ , P8 ₄ , PB ₄ to PB ₇ , D ₁₅ to D ₈		-0.3	—	0.8	V	
Output high voltage	All output pins	V_{OH}	$V_{CC} - 0.5$	—	—	V	$I_{OH} = -200 \mu\text{A}$
			3.5	—	—	V	$I_{OH} = -1 \text{ mA}$

Note: * If the A/D converter is not used, do not leave the AV_{CC} , AV_{SS} , and V_{REF} pins open.
Connect AV_{CC} and V_{REF} to V_{CC} , and connect AV_{SS} to V_{SS} .

Table 18-2 DC Characteristics (cont)

Conditions: $V_{CC} = 5.0 \text{ V} \pm 10\%$, $AV_{CC} = 5.0 \text{ V} \pm 10\%$, $V_{REF} = 4.5 \text{ V}$ to AV_{CC} ,
 $V_{SS} = AV_{SS} = 0 \text{ V}^*$ ¹, $T_a = -20^\circ\text{C}$ to $+75^\circ\text{C}$ (regular specifications),
 $T_a = -40^\circ\text{C}$ to $+85^\circ\text{C}$ (wide-range specifications)

Item	Symbol	Min	Typ	Max	Unit	Test Conditions
Output low voltage	All output pins (except RESO) V_{OL}	—	—	0.4	V	$I_{OL} = 1.6 \text{ mA}$
	Port B, A_{19} to A_0	—	—	1.0	V	$I_{OL} = 10 \text{ mA}$
	RESO	—	—	0.4	V	$I_{OL} = 2.6 \text{ mA}$
Input leakage current	STBY, NMI, $ I_{in} $ RES, MD_2 to MD_0	—	—	1.0	μA	$V_{in} = 0.5 \text{ to } V_{CC} - 0.5 \text{ V}$
	Port 7	—	—	1.0	μA	$V_{in} = 0.5 \text{ to } AV_{CC} - 0.5 \text{ V}$
Three-state leakage current (off state)	Ports 4, 6, 8 to B, A_{19} to A_0 , D_{15} to D_8	—	—	1.0	μA	$V_{in} = 0.5 \text{ to } V_{CC} - 0.5 \text{ V}$
	RESO	—	—	10.0	μA	$V_{in} = 0.5 \text{ to } V_{CC} - 0.5 \text{ V}$
Input pull-up current	Port 4 $-I_P$	50	—	300	μA	$V_{in} = 0 \text{ V}$
Input capacitance	NMI C_{in}	—	—	50	pF	$V_{in} = 0 \text{ V}$ $f = 1 \text{ MHz}$
	All input pins except NMI	—	—	15		$T_a = 25^\circ\text{C}$
Current dissipation ^{*2}	Normal operation I_{CC}^{*4}	—	45	70	mA	$f = 16 \text{ MHz}$
	Sleep mode	—	30	50	mA	$f = 16 \text{ MHz}$
	Standby mode ^{*3}	—	0.01	5.0	μA	$T_a \leq 50^\circ\text{C}$
		—	—	20.0	μA	$50^\circ\text{C} < T_a$

- Notes:
- If the A/D converter is not used, do not leave the AV_{CC} , AV_{SS} , and V_{REF} pins open. Connect AV_{CC} and V_{REF} to V_{CC} , and connect AV_{SS} to V_{SS} .
 - Current dissipation values are for $V_{IHmin} = V_{CC} - 0.5 \text{ V}$ and $V_{ILmax} = 0.5 \text{ V}$ with all output pins unloaded and the on-chip pull-up transistors in the off state.
 - The values are for $V_{RAM} \leq V_{CC} < 4.5 \text{ V}$, $V_{IHmin} = V_{CC} \times 0.9$, and $V_{ILmax} = 0.3 \text{ V}$.
 - I_{CC} depends on f as follows:
 $I_{CC \text{ max}} = 5.0 \text{ (mA)} + 4.06 \text{ (mA/MHz)} \times f$ [normal mode]
 $I_{CC \text{ max}} = 5.0 \text{ (mA)} + 2.81 \text{ (mA/MHz)} \times f$ [sleep mode]
 $I_{CC \text{ TYP}} = 5.0 \text{ (mA)} + 2.50 \text{ (mA/MHz)} \times f$ [normal mode]
 $I_{CC \text{ TYP}} = 5.0 \text{ (mA)} + 1.56 \text{ (mA/MHz)} \times f$ [sleep mode]

Table 18-2 DC Characteristics (cont)

Conditions: $V_{CC} = 5.0 \text{ V} \pm 10\%$, $AV_{CC} = 5.0 \text{ V} \pm 10\%$, $V_{REF} = 4.5 \text{ V}$ to AV_{CC} ,
 $V_{SS} = AV_{SS} = 0 \text{ V}^*$, $T_a = -20^\circ\text{C}$ to $+75^\circ\text{C}$ (regular specifications),
 $T_a = -40^\circ\text{C}$ to $+85^\circ\text{C}$ (wide-range specifications)

Item		Symbol	Min	Typ	Max	Unit	Test Conditions
Analog power supply current	During A/D conversion	$I_{A_{CC}}$	—	1.2	2.0	mA	$V_{REF} = 5.0 \text{ V}$
	Idle		—	0.01	5.0	μA	
Reference current	During A/D conversion	$I_{A_{CC}}$	—	0.3	0.6	mA	$V_{REF} = 5.0 \text{ V}$
	Idle		—	0.01	5.0	μA	
RAM standby voltage		V_{RAM}	2.0	—	—	V	

- Notes:
- If the A/D converter is not used, do not leave the AV_{CC} , AV_{SS} , and V_{REF} pins open. Connect AV_{CC} and V_{REF} to V_{CC} , and connect AV_{SS} to V_{SS} .
 - Current dissipation values are for $V_{IH_{min}} = V_{CC} - 0.5 \text{ V}$ and $V_{IL_{max}} = 0.5 \text{ V}$ with all output pins unloaded and the on-chip pull-up transistors in the off state.
 - The values are for $V_{RAM} \leq V_{CC} < 4.5 \text{ V}$, $V_{IH_{min}} = V_{CC} \times 0.9$, and $V_{IL_{max}} = 0.3 \text{ V}$.

Conditions: $V_{CC} = 2.7 \text{ V}$ to 5.5 V , $AV_{CC} = 2.7 \text{ V}$ to 5.5 V , $V_{REF} = 2.7 \text{ V}$ to AV_{CC} ,
 $V_{SS} = AV_{SS} = 0 \text{ V}^*$, $T_a = -20^\circ\text{C}$ to $+75^\circ\text{C}$ (regular specifications),
 $T_a = -40^\circ\text{C}$ to $+85^\circ\text{C}$ (wide-range specifications)

Item		Symbol	Min	Typ	Max	Unit	Test Conditions
Schmitt trigger input voltages	Port A, P8 ₀ to P8 ₂ , PB ₀ to PB ₃	V_T^-	$V_{CC} \times 0.2$	—	—	V	$V_{CC} \times 0.7$
		V_T^+	—	—	$V_{CC} \times 0.7$	V	
		$V_T^+ - V_T^-$	$V_{CC} \times 0.07$	—	—	V	
Input high voltage	RES, STBY, NMI, MD ₂ to MD ₀	V_{IH}	$V_{CC} \times 0.9$	—	$V_{CC} + 0.3$	V	$V_{CC} \times 0.7$
	EXTAL		$V_{CC} \times 0.7$	—	$V_{CC} + 0.3$	V	
	Port 7		$V_{CC} \times 0.7$	—	$AV_{CC} + 0.3$	V	
	Ports 4, 6, 9, P8 ₃ , P8 ₄ , PB ₄ to PB ₇ , D ₁₅ to D ₈		$V_{CC} \times 0.7$	—	$V_{CC} + 0.3$	V	$V_{CC} \times 0.7$

Note: * If the A/D converter is not used, do not leave the AV_{CC} , AV_{SS} , and V_{REF} pins open. Connect AV_{CC} and V_{REF} to V_{CC} , and connect AV_{SS} to V_{SS} .

Table 18-2 DC Characteristics (cont)

Conditions: $V_{CC} = 2.7 \text{ V to } 5.5 \text{ V}$, $AV_{CC} = 2.7 \text{ V to } 5.5 \text{ V}$, $V_{REF} = 2.7 \text{ V to } AV_{CC}$,
 $V_{SS} = AV_{SS} = 0 \text{ V}^*$, $T_a = -20^\circ\text{C} \text{ to } +75^\circ\text{C}$ (regular specifications),
 $T_a = -40^\circ\text{C} \text{ to } +85^\circ\text{C}$ (wide-range specifications)

Item	Symbol	Min	Typ	Max	Unit	Test Conditions
Input low voltage	$\overline{RES}, \overline{STBY}, MD_2 \text{ to } MD_0$	V_{IL}	-0.3	—	$V_{CC} \times 0.1 \text{ V}$	
	NMI, EXTAL, ports 4, 6, 7, 9, P8 ₃ , P8 ₄ PB ₄ to PB ₇ , D ₁₅ to D ₈		-0.3	—	$V_{CC} \times 0.2 \text{ V}$	$V_{CC} < 4.0 \text{ V}$
				0.8	V	$V_{CC} = 4.0 \text{ to } 5.5 \text{ V}$
Output high voltage	All output pins	V_{OH}	$V_{CC} - 0.5$	—	V	$I_{OH} = -200 \mu\text{A}$
			$V_{CC} - 1.0$	—	V	$V_{CC} \leq 4.5 \text{ V}$ $I_{OH} = -1 \text{ mA}$
			3.5	—	V	$4.5 \text{ V} < V_{CC} \leq 5.5 \text{ V}$ $I_{OH} = -1 \text{ mA}$
Output low voltage	All output pins (except \overline{RESO})	V_{OL}	—	—	0.4	V
	Port B, $A_{19} \text{ to } A_0$		—	—	1.0	V
						$V_{CC} \leq 4 \text{ V}$ $I_{OL} = 5 \text{ mA}$, $4 \text{ V} < V_{CC} \leq 5.5 \text{ V}$ $I_{OL} = 10 \text{ mA}$
	\overline{RESO}		—	—	0.4	V
Input leakage current	$\overline{STBY}, \overline{NMI}, \overline{RES}, MD_2 \text{ to } MD_0$	$ I_{in} $	—	—	1.0	μA
	Port 7		—	—	1.0	μA
						$V_{in} = 0.5 \text{ to } AV_{CC} - 0.5 \text{ V}$
Three-state leakage current (off state)	Ports 4, 6, 8 to B, A_{19} to $A_0, D_{15} \text{ to } D_8$	$ I_{TS1} $	—	—	1.0	μA
	\overline{RESO}		—	—	10.0	μA
Input pull-up current	Port 4	$-I_P$	10	—	300	μA
						$V_{CC} = 2.7 \text{ V to } 5.5 \text{ V}$, $V_{in} = 0 \text{ V}$

Note: * If the A/D converter is not used, do not leave the AV_{CC} , AV_{SS} , and V_{REF} pins open.
Connect AV_{CC} and V_{REF} to V_{CC} , and connect AV_{SS} to V_{SS} .

Table 18-2 DC Characteristics (cont)

Conditions: $V_{CC} = 2.7 \text{ V to } 5.5 \text{ V}$, $AV_{CC} = 2.7 \text{ V to } 5.5 \text{ V}$, $V_{REF} = 2.7 \text{ V to } AV_{CC}$,
 $V_{SS} = AV_{SS} = 0 \text{ V}^*$ ¹, $T_a = -20^\circ\text{C to } +75^\circ\text{C}$ (regular specifications),
 $T_a = -40^\circ\text{C to } +85^\circ\text{C}$ (wide-range specifications)

Item		Symbol	Min	Typ	Max	Unit	Test Conditions
Input capacitance	NMI	C_{in}	—	—	50	pF	$V_{in} = 0 \text{ V}$ $f = 1 \text{ MHz}$ $T_a = 25^\circ\text{C}$
	All input pins except NMI		—	—	15		
Current dissipation ^{*2}	Normal operation	I_{CC}^{*4}	—	25 (5.0 V)	31.8 (5.5 V)	mA	$f = 8 \text{ MHz}$
	Sleep mode		—	15 (5.0 V)	23.0 (5.5 V)	mA	$f = 8 \text{ MHz}$
	Standby mode ^{*3}		—	0.01	5.0	µA	$T_a \leq 50^\circ\text{C}$
			—	—	20.0	µA	$50^\circ\text{C} < T_a$
Analog power supply current	During A/D conversion	$A_{I_{CC}}$	—	1.0	2.0	mA	$AV_{CC} = 3.0 \text{ V}$
			—	1.2	—	mA	$AV_{CC} = 5.0 \text{ V}$
	Idle		—	0.01	5.0	µA	
Reference current	During A/D conversion	$A_{I_{CC}}$	—	0.2	0.4	mA	$V_{REF} = 3.0 \text{ V}$
			—	0.3	—	mA	$V_{REF} = 5.0 \text{ V}$
	Idle		—	0.01	5.0	µA	
RAM standby voltage		V_{RAM}	2.0	—	—	V	

- Notes:
- If the A/D converter is not used, do not leave the AV_{CC} , AV_{SS} , and V_{REF} pins open. Connect AV_{CC} and V_{REF} to V_{CC} , and connect AV_{SS} to V_{SS} .
 - Current dissipation values are for $V_{IHmin} = V_{CC} - 0.5 \text{ V}$ and $V_{ILmax} = 0.5 \text{ V}$ with all output pins unloaded and the on-chip pull-up transistors in the off state.
 - The values are for $V_{RAM} \leq V_{CC} < 2.7 \text{ V}$, $V_{IHmin} = V_{CC} \times 0.9$, and $V_{ILmax} = 0.3 \text{ V}$.
 - I_{CC} depends on V_{CC} and f as follows:
 $I_{CCmax} = 1.0 \text{ (mA)} + 0.7 \text{ (mA/MHz · V)} \times V_{CC} \times f$ [normal mode]
 $I_{CCmax} = 1.0 \text{ (mA)} + 0.5 \text{ (mA/MHz · V)} \times V_{CC} \times f$ [sleep mode]

Table 18-2 DC Characteristics (cont)

Conditions: $V_{CC} = 3.0\text{ V}$ to 5.5 V , $AV_{CC} = 3.0\text{ V}$ to AV_{CC} , $V_{REF} = 3.0\text{ V}$ to AV_{CC} ,
 $V_{SS} = AV_{SS} = 0\text{ V}^*$, $T_a = -20^\circ\text{C}$ to $+75^\circ\text{C}$ (regular specifications),
 $T_a = -40^\circ\text{C}$ to $+85^\circ\text{C}$ (wide-range specifications)

Item		Symbol	Min	Typ	Max	Unit	Test Conditions
Schmitt trigger input voltages	Port A, P8 ₀ to P8 ₂ , PB ₀ to PB ₃	V_T^-	$V_{CC} \times 0.2$	—	—	V	
		V_T^+	—	—	$V_{CC} \times 0.7$	V	
		$V_T^+ - V_T^-$	$V_{CC} \times 0.07$	—	—	V	
Input high voltage	RES, STBY, NMI, MD ₂ to MD ₀	V_{IH}	$V_{CC} \times 0.9$	—	$V_{CC} + 0.3$	V	
	EXTAL		$V_{CC} \times 0.7$	—	$V_{CC} + 0.3$	V	
	Port 7		$V_{CC} \times 0.7$	—	$AV_{CC} + 0.3$ V		
	Ports 4, 6, 9, P8 ₃ , P8 ₄ , PB ₄ to PB ₇ , D ₁₅ to D ₈		$V_{CC} \times 0.7$	—	$V_{CC} + 0.3$	V	
Input low voltage	RES, STBY, MD ₂ to MD ₀	V_{IL}	-0.3	—	$V_{CC} \times 0.1$	V	
	NMI, EXTAL, ports 4, 6, 7, 9, P8 ₃ , P8 ₄ , PB ₄ to PB ₇ , D ₁₅ to D ₈		-0.3	—	$V_{CC} \times 0.2$	V	$V_{CC} < 4\text{ V}$
			-0.3	—	0.8	V	$4\text{ V} \leq V_{CC} \leq 5.5\text{ V}$
Output high voltage	All output pins	V_{OH}	$V_{CC} - 0.5$	—	—	V	$I_{OH} = -200\text{ }\mu\text{A}$
			$V_{CC} - 1.0$	—	—	V	$V_{CC} \leq 4.5\text{ V}$ $I_{OH} = -1\text{ mA}$
			3.5	—	—	V	$4.5 \leq V_{CC} \leq 5.5\text{ V}$ $I_{OH} = -1\text{ mA}$

Note: * If the A/D converter is not used, do not leave the AV_{CC} , AV_{SS} , and V_{REF} pins open.
Connect AV_{CC} and V_{REF} to V_{CC} , and connect AV_{SS} to V_{SS} .

Table 18-2 DC Characteristics (cont)

Conditions: $V_{CC} = 3.0 \text{ V to } 5.5 \text{ V}$, $AV_{CC} = 3.0 \text{ V to } AV_{CC}$, $V_{REF} = 3.0 \text{ V to } AV_{CC}$,
 $V_{SS} = AV_{SS} = 0 \text{ V}^*$, $T_a = -20^\circ\text{C to } +75^\circ\text{C}$ (regular specifications),
 $T_a = -40^\circ\text{C to } +85^\circ\text{C}$ (wide-range specifications)

Item	Symbol	Min	Typ	Max	Unit	Test Conditions
Output low voltage	All output pins (except RESO) V_{OL}	—	—	0.4	V	$I_{OL} = 1.6 \text{ mA}$
	Port B, A_{19} to A_0	—	—	1.0	V	$V_{CC} \leq 4 \text{ V}$, $I_{OL} = 5 \text{ mA}$, $4 \text{ V} < V_{CC} \leq 5.5 \text{ V}$, $I_{OL} = 10 \text{ mA}$
	RESO	—	—	0.4	V	$I_{OL} = 1.6 \text{ mA}$
Input leakage current	STBY, NMI, RES, MD_2 to MD_0	—	—	1.0	μA	$V_{in} = 0.5 \text{ to } V_{CC} - 0.5 \text{ V}$
	Port 7	—	—	1.0	μA	$V_{in} = 0.5 \text{ to } AV_{CC} - 0.5 \text{ V}$
Three-state leakage current (off state)	Ports 4, 6, 8 to B, A_{19} to A_0 , D_{15} to D_8	—	—	1.0	μA	$V_{in} = 0.5 \text{ to } V_{CC} - 0.5 \text{ V}$
	RESO	—	—	10.0	μA	
Input pull-up current	Port 4	$-I_P$	10	—	300	μA $V_{CC} = 3.0 \text{ V to } 5.5 \text{ V}$ $V_{in} = 0 \text{ V}$
Input capacitance	NMI	C_{in}	—	—	50	pF $V_{in} = 0 \text{ V}, f = 1 \text{ MHz}$, $T_a = 25^\circ\text{C}$
	All input pins except NMI		—	—	15	
Current dissipation* ²	Normal operation	I_{CC}	—	30 (5.0 V)	39.5 (5.5 V)	mA $f = 10 \text{ MHz}$
	Sleep mode		—	20 (5.0 V)	28.5 (5.5 V)	mA $f = 10 \text{ MHz}$
	Standby mode* ³		—	0.01	5.0	μA $T_a \leq 50^\circ\text{C}$
			—	—	20.0	μA $50^\circ\text{C} < T_a$

- Notes:
- If the A/D converter is not used, do not leave the AV_{CC} , AV_{SS} , and V_{REF} pins open. Connect AV_{CC} and V_{REF} to V_{CC} , and connect AV_{SS} to V_{SS} .
 - Current dissipation values are for $V_{IHmin} = V_{CC} - 0.5 \text{ V}$ and $V_{ILmax} = 0.5 \text{ V}$ with all output pins unloaded and the on-chip pull-up transistors in the off state.
 - The values are for $V_{RAM} \leq V_{CC} < 3.0 \text{ V}$, $V_{IHmin} = V_{CC} \times 0.9$, and $V_{ILmax} = 0.3 \text{ V}$.
 - I_{CC} depends on V_{CC} and f as follows:
 $I_{CC max} = 1.0 \text{ (mA)} + 0.7 \text{ (mA/MHz} \cdot \text{V}) \times V_{CC} \times f$ [normal mode]
 $I_{CC max} = 1.0 \text{ (mA)} + 0.5 \text{ (mA/MHz} \cdot \text{V}) \times V_{CC} \times f$ [sleep mode]

Table 18-2 DC Characteristics (cont)

Conditions: $V_{CC} = 3.0\text{ V}$ to 5.5 V , $AV_{CC} = 3.0\text{ V}$ to AV_{CC} ,
 $V_{SS} = AV_{SS} = 0\text{ V}$ ¹, $T_a = -20^\circ\text{C}$ to $+75^\circ\text{C}$ (regular specifications),
 $T_a = -40^\circ\text{C}$ to $+85^\circ\text{C}$ (wide-range specifications)

Item	Symbol	Min	Typ	Max	Unit	Test Conditions
Analog power supply current	During A/D conversion	—	1.0	2.0	mA	$AV_{CC} = 3.0\text{ V}$
		—	1.2	—	mA	$AV_{CC} = 5.0\text{ V}$
	Idle	—	0.01	5.0	μA	
Reference current	During A/D conversion	—	0.2	0.4	mA	$V_{REF} = 3.0\text{ V}$
		—	0.3	—	mA	$V_{REF} = 5.0\text{ V}$
	Idle	—	0.01	5.0	μA	
RAM standby voltage	V_{RAM}	2.0	—	—	V	

- Notes:
- If the A/D converter is not used, do not leave the AV_{CC} , AV_{SS} , and V_{REF} pins open. Connect AV_{CC} and V_{REF} to V_{CC} , and connect AV_{SS} to V_{SS} .
 - Current dissipation values are for $V_{IHmin} = V_{CC} - 0.5\text{ V}$ and $V_{ILmax} = 0.5\text{ V}$ with all output pins unloaded and the on-chip pull-up transistors in the off state.
 - The values are for $V_{RAM} \leq V_{CC} < 3.0\text{ V}$, $V_{IHmin} = V_{CC} \times 0.9$, and $V_{ILmax} = 0.3\text{ V}$.

Table 18-3 Permissible Output CurrentsConditions: $V_{CC} = 2.7 \text{ V to } 5.5 \text{ V}$, $AV_{CC} = 2.7 \text{ V to } 5.5 \text{ V}$, $V_{REF} = 2.7 \text{ V to } AV_{CC}$, $V_{SS} = AV_{SS} = 0 \text{ V}$, $T_a = -20^\circ\text{C to } +75^\circ\text{C}$ (regular specifications), $T_a = -40^\circ\text{C to } +85^\circ\text{C}$ (wide-range specifications)

Item		Symbol	Min	Typ	Max	Unit
Permissible output low current (per pin)	Port B, A ₁₉ to A ₀	I _{OL}	—	—	10	mA
	Other output pins		—	—	2.0	mA
Permissible output low current (total)	Total of 28 pins including port B and A ₁₉ to A ₀	ΣI_{OL}	—	—	80	mA
	Total of all output pins, including the above		—	—	120	mA
Permissible output high current (per pin)	All output pins	I _{OH}	—	—	2.0	mA
Permissible output high current (total)	Total of all output pins	ΣI_{OH}	—	—	40	mA

- Notes:
1. To protect chip reliability, do not exceed the output current values in table 18-3.
 2. When driving a darlington pair or LED, always insert a current-limiting resistor in the output line, as shown in figures 18-1 and 18-2.

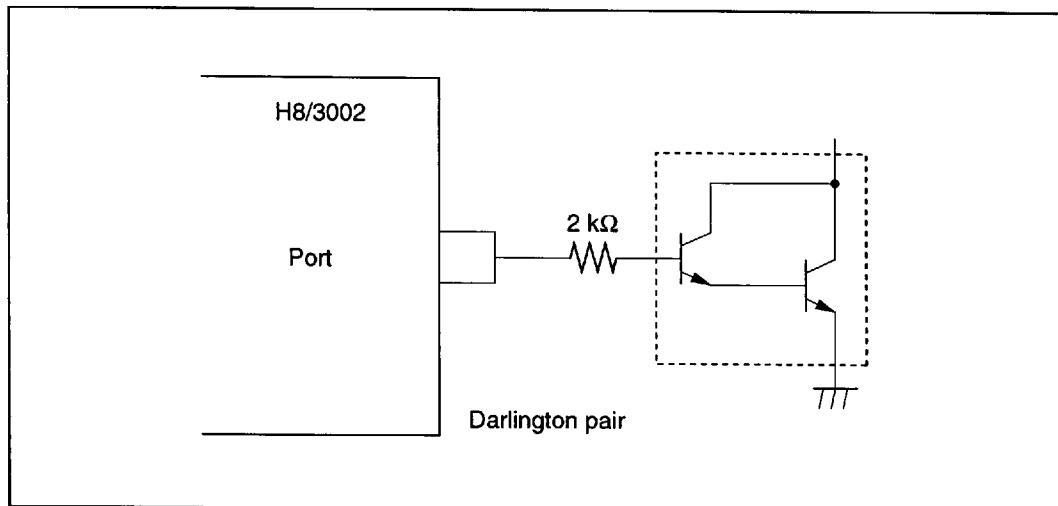


Figure 18-1 Darlington Pair Drive Circuit (Example)

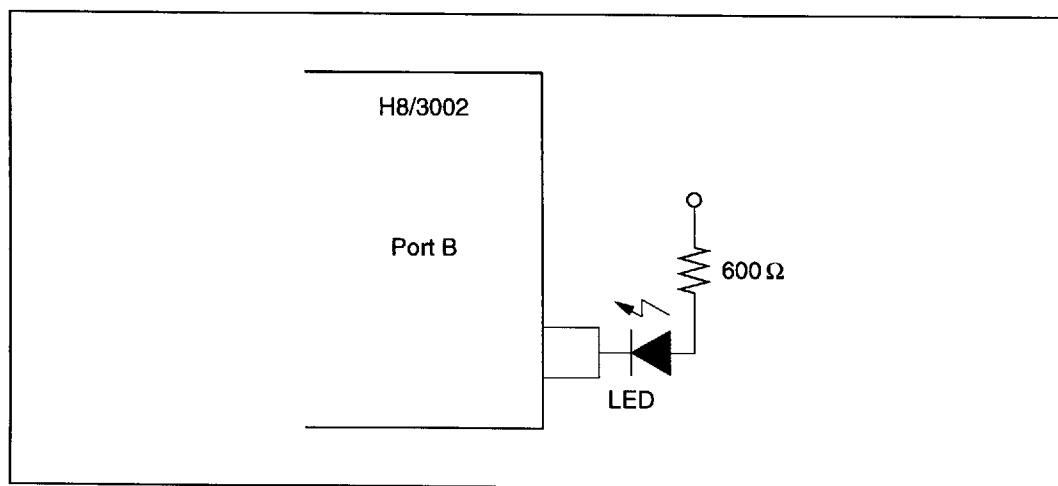


Figure 18-2 LED Drive Circuit (Example)

18.2.2 AC Characteristics

Bus timing parameters are listed in table 18-4. Refresh controller bus timing parameters are listed in table 18-5. Control signal timing parameters are listed in table 18-6. Timing parameters of the on-chip supporting modules are listed in table 18-7.

Table 18-4 Bus Timing (1)

Condition A: $V_{CC} = 2.7 \text{ V to } 5.5 \text{ V}$, $AV_{CC} = 2.7 \text{ V to } 5.5 \text{ V}$, $V_{REF} = 2.7 \text{ V to } AV_{CC}$,
 $V_{SS} = AV_{SS} = 0 \text{ V}$, $\phi = 2 \text{ MHz to } 8 \text{ MHz}$, $T_a = -20^\circ\text{C to } +75^\circ\text{C}$ (regular specifications), $T_a = -40^\circ\text{C to } +85^\circ\text{C}$ (wide-range specifications)

Condition B: $V_{CC} = 3.0 \text{ V to } 5.5 \text{ V}$, $AV_{CC} = 3.0 \text{ V to } 5.5 \text{ V}$, $V_{REF} = 3.0 \text{ V to } AV_{CC}$,
 $V_{SS} = AV_{SS} = 0 \text{ V}$, $\phi = 2 \text{ MHz to } 10 \text{ MHz}$, $T_a = -20^\circ\text{C to } +75^\circ\text{C}$ (regular specifications), $T_a = -40^\circ\text{C to } +85^\circ\text{C}$ (wide-range specifications)

Condition C: $V_{CC} = 5.0 \text{ V} \pm 10\%$, $AV_{CC} = 5.0 \text{ V} \pm 10\%$, $V_{REF} = 4.5 \text{ V to } AV_{CC}$,
 $V_{SS} = AV_{SS} = 0 \text{ V}$, $\phi = 2 \text{ MHz to } 16 \text{ MHz}$, $T_a = -20^\circ\text{C to } +75^\circ\text{C}$ (regular specifications), $T_a = -40^\circ\text{C to } +85^\circ\text{C}$ (wide-range specifications)

Item	Symbol	Condition A		Condition B		Condition C		Unit	Test Conditions
		8 MHz	10 MHz	Min	Max	Min	Max		
Clock cycle time	t_{CYC}	125	500	100	500	62.5	500	ns	Figure 18-4, Figure 18-5
Clock low pulse width	t_{CL}	40	—	30	—	20	—	t_{cyc}	
Clock high pulse width	t_{CH}	40	—	30	—	20	—	—	
Clock rise time	t_{CR}	—	20	—	15	—	10	ns	
Clock fall time	t_{CF}	—	20	—	15	—	10	—	
Address delay time	t_{AD}	—	60	—	50	—	30	—	
Address hold time	t_{AH}	25	—	20	—	10	—	—	
Address strobe delay time	t_{ASD}	—	60	—	40	—	30	—	
Write strobe delay time	t_{WSD}	—	60	—	50	—	30	—	
Strobe delay time	t_{SD}	—	60	—	50	—	30	—	
Write data strobe pulse width 1	t_{WSW1*}	85	—	60	—	35	—	—	
Write data strobe pulse width 2	t_{WSW2*}	150	—	110	—	65	—	—	
Address setup time 1	t_{AS1}	20	—	15	—	10	—	—	
Address setup time 2	t_{AS2}	80	—	65	—	40	—	—	
Read data setup time	t_{RDS}	50	—	35	—	20	—	—	
Read data hold time	t_{RDH}	0	—	0	—	0	—	—	

Table 18-4 Bus Timing (cont)

Condition A: $V_{CC} = 2.7 \text{ V to } 5.5 \text{ V}$, $AV_{CC} = 2.7 \text{ V to } 5.5 \text{ V}$, $V_{REF} = 2.7 \text{ V to } AV_{CC}$,
 $V_{SS} = AV_{SS} = 0 \text{ V}$, $\phi = 2 \text{ MHz to } 8 \text{ MHz}$, $T_a = -20^\circ\text{C to } +75^\circ\text{C}$ (regular specifications), $T_a = -40^\circ\text{C to } +85^\circ\text{C}$ (wide-range specifications)

Condition B: $V_{CC} = 3.0 \text{ V to } 5.5 \text{ V}$, $AV_{CC} = 3.0 \text{ V to } 5.5 \text{ V}$, $V_{REF} = 3.0 \text{ V to } AV_{CC}$,
 $V_{SS} = AV_{SS} = 0 \text{ V}$, $\phi = 2 \text{ MHz to } 10 \text{ MHz}$, $T_a = -20^\circ\text{C to } +75^\circ\text{C}$ (regular specifications), $T_a = -40^\circ\text{C to } +85^\circ\text{C}$ (wide-range specifications)

Condition C: $V_{CC} = 5.0 \text{ V} \pm 10\%$, $AV_{CC} = 5.0 \text{ V} \pm 10\%$, $V_{REF} = 4.5 \text{ V to } AV_{CC}$,
 $V_{SS} = AV_{SS} = 0 \text{ V}$, $\phi = 2 \text{ MHz to } 16 \text{ MHz}$, $T_a = -20^\circ\text{C to } +75^\circ\text{C}$ (regular specifications), $T_a = -40^\circ\text{C to } +85^\circ\text{C}$ (wide-range specifications)

Item	Symbol	Condition A		Condition B		Condition C		Unit	Test Conditions	
		8 MHz	Min	Max	Min	Max	Min	Max		
Write data delay time	t_{WDD}	—	—	75	—	75	—	60	ns	Figure 18-4, Figure 18-5
Write data setup time 1	t_{WDS1}	90	—	—	65	—	35	—	—	
Write data setup time 2	t_{WDS2}	15	—	—	10	—	5	—	—	
Write data hold time	t_{WDH}	25	—	—	20	—	20	—	—	
Read data access time 1	t_{ACC1*}	—	—	110	—	100	—	55	—	
Read data access time 2	t_{ACC2*}	—	—	230	—	200	—	115	—	
Read data access time 3	t_{ACC3*}	—	—	55	—	50	—	25	—	
Read data access time 4	t_{ACC4*}	—	—	160	—	150	—	85	—	
Precharge time	t_{PCH*}	85	—	—	60	—	40	—	—	
Wait setup time	t_{WTS}	40	—	—	40	—	25	—	ns	Figure 18-6
Wait hold time	t_{WTH}	10	—	—	10	—	5	—	—	
Bus request setup time	t_{BRQS}	40	—	—	40	—	40	—	ns	Figure 18-18
Bus acknowledge delay time 1	t_{BACD1}	—	—	60	—	50	—	30	—	
Bus acknowledge delay time 2	t_{BACD2}	—	—	60	—	50	—	30	—	
Bus-floating time	t_{BZD}	—	—	70	—	70	—	40	—	

Note is on next page.

Note: At 8 MHz (condition A), the times below depend as indicated on the clock cycle time.

$$\begin{aligned}t_{ACC1} &= 1.5 \times t_{cyc} - 78 \text{ (ns)} & t_{WSW1} &= 1.0 \times t_{cyc} - 40 \text{ (ns)} \\t_{ACC2} &= 2.5 \times t_{cyc} - 83 \text{ (ns)} & t_{WSW2} &= 1.5 \times t_{cyc} - 38 \text{ (ns)} \\t_{ACC3} &= 1.0 \times t_{cyc} - 70 \text{ (ns)} & t_{PCH} &= 1.0 \times t_{cyc} - 40 \text{ (ns)} \\t_{ACC4} &= 2.0 \times t_{cyc} - 90 \text{ (ns)}\end{aligned}$$

At 10 MHz (condition B), the times below depend as indicated on the clock cycle time.

$$\begin{aligned}t_{ACC1} &= 1.5 \times t_{cyc} - 50 \text{ (ns)} & t_{WSW1} &= 1.0 \times t_{cyc} - 40 \text{ (ns)} \\t_{ACC2} &= 2.5 \times t_{cyc} - 50 \text{ (ns)} & t_{WSW2} &= 1.5 \times t_{cyc} - 40 \text{ (ns)} \\t_{ACC3} &= 1.0 \times t_{cyc} - 50 \text{ (ns)} & t_{PCH} &= 1.0 \times t_{cyc} - 40 \text{ (ns)} \\t_{ACC4} &= 2.0 \times t_{cyc} - 50 \text{ (ns)}\end{aligned}$$

At 16 MHz (condition C), the times below depend as indicated on the clock cycle time.

$$\begin{aligned}t_{ACC1} &= 1.5 \times t_{cyc} - 39 \text{ (ns)} & t_{WSW1} &= 1.0 \times t_{cyc} - 28 \text{ (ns)} \\t_{ACC2} &= 2.5 \times t_{cyc} - 41 \text{ (ns)} & t_{WSW2} &= 1.5 \times t_{cyc} - 28 \text{ (ns)} \\t_{ACC3} &= 1.0 \times t_{cyc} - 38 \text{ (ns)} & t_{PCH} &= 1.0 \times t_{cyc} - 23 \text{ (ns)} \\t_{ACC4} &= 2.0 \times t_{cyc} - 40 \text{ (ns)}\end{aligned}$$

Table 18-5 Refresh Controller Bus Timing

Condition A: $V_{CC} = 2.7 \text{ V to } 5.5 \text{ V}$, $AV_{CC} = 2.7 \text{ V to } 5.5 \text{ V}$, $V_{REF} = 2.7 \text{ V to } AV_{CC}$,
 $V_{SS} = AV_{SS} = 0 \text{ V}$, $\phi = 2 \text{ MHz to } 8 \text{ MHz}$, $T_a = -20^\circ\text{C to } +75^\circ\text{C}$ (regular specifications), $T_a = -40^\circ\text{C to } +85^\circ\text{C}$ (wide-range specifications)

Condition B: $V_{CC} = 3.0 \text{ V to } 5.5 \text{ V}$, $AV_{CC} = 3.0 \text{ V to } 5.5 \text{ V}$, $V_{REF} = 3.0 \text{ V to } AV_{CC}$,
 $V_{SS} = AV_{SS} = 0 \text{ V}$, $\phi = 2 \text{ MHz to } 8 \text{ MHz}$, $T_a = -20^\circ\text{C to } +75^\circ\text{C}$ (regular specifications), $T_a = -40^\circ\text{C to } +85^\circ\text{C}$ (wide-range specifications)

Condition C: $V_{CC} = 5.0 \text{ V} \pm 10\%$, $AV_{CC} = 5.0 \text{ V} \pm 10\%$, $V_{REF} = 4.5 \text{ V to } AV_{CC}$,
 $V_{SS} = AV_{SS} = 0 \text{ V}$, $\phi = 2 \text{ MHz to } 16 \text{ MHz}$, $T_a = -20^\circ\text{C to } +75^\circ\text{C}$ (regular specifications), $T_a = -40^\circ\text{C to } +85^\circ\text{C}$ (wide-range specifications)

Item	Symbol	Condition A		Condition B		Condition C		Test Conditions
		8 MHz	10 MHz	10 MHz	16 MHz	Min	Max	
RAS delay time 1	t_{RAD1}	—	60	—	50	—	30	ns
RAS delay time 2	t_{RAD2}	—	60	—	50	—	30	
RAS delay time 3	t_{RAD3}	—	60	—	50	—	30	
Row address hold time*	t_{RAH}	25	—	20	—	15	—	
RAS precharge time*	t_{RP}	85	—	70	—	40	—	
CAS to RAS precharge time*	t_{CRP}	85	—	70	—	40	—	
CAS pulse width	t_{CAS}	110	—	85	—	40	—	
RAS access time*	t_{RAC}	—	160	—	150	—	85	
Address access time	t_{AA}	—	105	—	75	—	55	
CAS access time	t_{CAC}	—	50	—	50	—	25	
Write data setup time 3	t_{WD3}	75	—	50	—	40	—	
CAS setup time*	t_{CSR}	20	—	15	—	15	—	
Read strobe delay time	t_{RSD}	—	60	—	50	—	30	

Note: At 8 MHz (condition A), the times below depend as indicated on the clock cycle time.

$$t_{RAH} = 0.5 \times t_{cyc} - 38 \text{ (ns)} \quad t_{CAC} = 1.0 \times t_{cyc} - 75 \text{ (ns)}$$

$$t_{RAC} = 2.0 \times t_{cyc} - 90 \text{ (ns)} \quad t_{CSR} = 0.5 \times t_{cyc} - 43 \text{ (ns)}$$

$$t_{RP} = t_{CRP} = 1.0 \times t_{cyc} - 40 \text{ (ns)}$$

At 10 MHz (condition B), the times below depend as indicated on the clock cycle time.

$$t_{RAH} = 0.5 \times t_{cyc} - 30 \text{ (ns)} \quad t_{CAC} = 1.0 \times t_{cyc} - 50 \text{ (ns)}$$

$$t_{RAC} = 2.0 \times t_{cyc} - 50 \text{ (ns)} \quad t_{CSR} = 0.5 \times t_{cyc} - 35 \text{ (ns)}$$

$$t_{RP} = t_{CRP} = 1.0 \times t_{cyc} - 30 \text{ (ns)}$$

At 16 MHz (condition C), the times below depend as indicated on the clock cycle time.

$$t_{RAH} = 0.5 \times t_{cyc} - 16 \text{ (ns)} \quad t_{CAC} = 1.0 \times t_{cyc} - 38 \text{ (ns)}$$

$$t_{RAC} = 2.0 \times t_{cyc} - 40 \text{ (ns)} \quad t_{CSR} = 0.5 \times t_{cyc} - 16 \text{ (ns)}$$

$$t_{RP} = t_{CRP} = 1.0 \times t_{cyc} - 23 \text{ (ns)}$$

Table 18-6 Control Signal Timing

Condition A: $V_{CC} = 2.7 \text{ V to } 5.5 \text{ V}$, $AV_{CC} = 2.7 \text{ V to } 5.5 \text{ V}$, $V_{REF} = 2.7 \text{ V to } AV_{CC}$,
 $V_{SS} = AV_{SS} = 0 \text{ V}$, $\phi = 2 \text{ MHz to } 8 \text{ MHz}$, $T_a = -20^\circ\text{C to } +75^\circ\text{C}$ (regular
specifications), $T_a = -40^\circ\text{C to } +85^\circ\text{C}$ (wide-range specifications)

Condition B: $V_{CC} = 3.0 \text{ V to } 5.5 \text{ V}$, $AV_{CC} = 3.0 \text{ V to } 5.5 \text{ V}$, $V_{REF} = 3.0 \text{ V to } AV_{CC}$,
 $V_{SS} = AV_{SS} = 0 \text{ V}$, $\phi = 2 \text{ MHz to } 10 \text{ MHz}$, $T_a = -20^\circ\text{C to } +75^\circ\text{C}$ (regular
specifications), $T_a = -40^\circ\text{C to } +85^\circ\text{C}$ (wide-range specifications)

Condition C: $V_{CC} = 5.0 \text{ V} \pm 10\%$, $AV_{CC} = 5.0 \text{ V} \pm 10\%$, $V_{REF} = 4.5 \text{ V to } AV_{CC}$,
 $V_{SS} = AV_{SS} = 0 \text{ V}$, $\phi = 2 \text{ MHz to } 16 \text{ MHz}$, $T_a = -20^\circ\text{C to } +75^\circ\text{C}$ (regular
specifications), $T_a = -40^\circ\text{C to } +85^\circ\text{C}$ (wide-range specifications)

Item	Symbol	Condition A		Condition B		Condition C		Test Conditions	
		8 MHz	Min	Max	Min	Max	Min	Max	
RES setup time	t_{RESS}	200	—	200	—	200	—	ns	Figure 18-15
RES pulse width	t_{RESW}	10	—	10	—	10	—	t_{cyc}	
RESO output delay time	t_{RESD}	—	100	—	100	—	100	ns	Figure 18-16
RESO output pulse width	t_{RESOW}	132	—	132	—	132	—	t_{cyc}	
NMI setup time (NMI, $\overline{IRQ_5}$ to $\overline{IRQ_0}$)	t_{NMIS}	150	—	150	—	150	—	ns	Figure 18-17
NMI hold time (NMI, $\overline{IRQ_5}$ to $\overline{IRQ_0}$)	t_{NMIH}	10	—	10	—	10	—	ns	
Interrupt pulse width (NMI, $\overline{IRQ_2}$ to $\overline{IRQ_0}$ when exiting software standby mode)	t_{NMIW}	200	—	200	—	200	—	ns	
Clock oscillator settling time at reset (crystal)	t_{OSC1}	20	—	20	—	20	—	ms	Figure 18-19
Clock oscillator settling time in software standby (crystal)	t_{OSC2}	8	—	8	—	8	—	ms	Figure 17-1

Table 18-7 Timing of On-Chip Supporting Modules

Condition A: $V_{CC} = 2.7 \text{ V to } 5.5 \text{ V}$, $AV_{CC} = 2.7 \text{ V to } 5.5 \text{ V}$, $V_{REF} = 2.7 \text{ V to } AV_{CC}$,
 $V_{SS} = AV_{SS} = 0 \text{ V}$, $\phi = 2 \text{ MHz to } 8 \text{ MHz}$, $T_a = -20^\circ\text{C to } +75^\circ\text{C}$ (regular specifications), $T_a = -40^\circ\text{C to } +85^\circ\text{C}$ (wide-range specifications)

Condition B: $V_{CC} = 3.0 \text{ V to } 5.5 \text{ V}$, $AV_{CC} = 3.0 \text{ V to } 5.5 \text{ V}$, $V_{REF} = 3.0 \text{ V to } AV_{CC}$,
 $V_{SS} = AV_{SS} = 0 \text{ V}$, $\phi = 2 \text{ MHz to } 10 \text{ MHz}$, $T_a = -20^\circ\text{C to } +75^\circ\text{C}$ (regular specifications), $T_a = -40^\circ\text{C to } +85^\circ\text{C}$ (wide-range specifications)

Condition C: $V_{CC} = 5.0 \text{ V} \pm 10\%$, $AV_{CC} = 5.0 \text{ V} \pm 10\%$, $V_{REF} = 4.5 \text{ V to } AV_{CC}$,
 $V_{SS} = AV_{SS} = 0 \text{ V}$, $\phi = 2 \text{ MHz to } 16 \text{ MHz}$, $T_a = -20^\circ\text{C to } +75^\circ\text{C}$ (regular specifications), $T_a = -40^\circ\text{C to } +85^\circ\text{C}$ (wide-range specifications)

Item	Symbol	Condition A		Condition B		Condition C		Test Conditions			
		8 MHz	10 MHz	10 MHz	16 MHz	Min	Max				
DMAC	DREQ setup time	t_{DQSQS}	40	—	40	—	30	—	ns	Figure 18-27 Figure 18-25, Figure 18-26	
	DREQ hold time	t_{DQRQH}	10	—	10	—	10	—			
	TEND delay time 1	t_{TED1}	—	100	—	100	—	50			
	TEND delay time 2	t_{TED2}	—	100	—	100	—	50			
ITU	Timer output delay time	t_{TOCD}	—	100	—	100	—	100	ns	Figure 18-21 Figure 18-22 t_{cyc}	
	Timer input setup time	t_{TICS}	50	—	50	—	50	—			
	Timer clock input setup time	t_{TCKS}	50	—	50	—	50	—			
	Single clock edge	t_{TCKWH}	1.5	—	1.5	—	1.5	—			
	pulse width	Both edges	t_{TCKWL}	2.5	—	2.5	—	2.5	—		
SCI	Input clock cycle	Asynchronous	t_{Scyc}	4	—	4	—	4	—	t_{Scyc}	Figure 18-23
		Synchronous	t_{Scyc}	6	—	6	—	6	—		
	Input clock rise time	t_{SCKR}	—	1.5	—	1.5	—	1.5	—		
	Input clock fall time	t_{SCKF}	—	1.5	—	1.5	—	1.5	—		
	Input clock pulse width	t_{SCKW}	0.4	0.6	0.4	0.6	0.4	0.6	—		

Table 18-7 Timing of On-Chip Supporting Modules (cont)

Condition A: $V_{CC} = 2.7 \text{ V to } 5.5 \text{ V}$, $AV_{CC} = 2.7 \text{ V to } 5.5 \text{ V}$, $V_{REF} = 2.7 \text{ V to } AV_{CC}$,
 $V_{SS} = AV_{SS} = 0 \text{ V}$, $\phi = 2 \text{ MHz to } 8 \text{ MHz}$, $T_a = -20^\circ\text{C to } +75^\circ\text{C}$ (regular specifications), $T_a = -40^\circ\text{C to } +85^\circ\text{C}$ (wide-range specifications)

Condition B: $V_{CC} = 3.0 \text{ V to } 5.5 \text{ V}$, $AV_{CC} = 3.0 \text{ V to } 5.5 \text{ V}$, $V_{REF} = 3.0 \text{ V to } AV_{CC}$,
 $V_{SS} = AV_{SS} = 0 \text{ V}$, $\phi = 2 \text{ MHz to } 10 \text{ MHz}$, $T_a = -20^\circ\text{C to } +75^\circ\text{C}$ (regular specifications), $T_a = -40^\circ\text{C to } +85^\circ\text{C}$ (wide-range specifications)

Condition C: $V_{CC} = 5.0 \text{ V} \pm 10\%$, $AV_{CC} = 5.0 \text{ V} \pm 10\%$, $V_{REF} = 4.5 \text{ V to } AV_{CC}$,
 $V_{SS} = AV_{SS} = 0 \text{ V}$, $\phi = 2 \text{ MHz to } 16 \text{ MHz}$, $T_a = -20^\circ\text{C to } +75^\circ\text{C}$ (regular specifications), $T_a = -40^\circ\text{C to } +85^\circ\text{C}$ (wide-range specifications)

Item	Symbol	Condition A		Condition B		Condition C		Test Conditions
		8 MHz		10 MHz		16 MHz		
		Min	Max	Min	Max	Min	Max	Unit
SCI	t_{TXD}	—	100	—	100	—	100	ns
	t_{RXS}	100	—	100	—	100	—	Figure 18-24
	t_{RXH}	100	—	100	—	100	—	
	t_{PRH}	0	—	0	—	0	—	
Ports and TPC	t_{PWD}	—	100	—	100	—	100	ns
	t_{PRS}	50	—	50	—	50	—	Figure 18-20
	t_{PRH}	50	—	50	—	50	—	

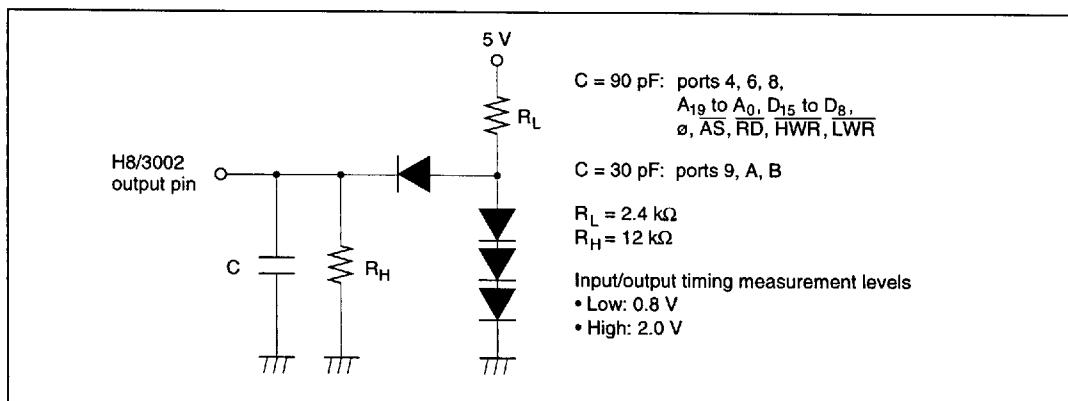


Figure 18-3 Output Load Circuit

18.2.3 A/D Conversion Characteristics

Table 18-8 lists the A/D conversion characteristics.

Table 18-8 A/D Converter Characteristics

Condition A: $V_{CC} = 2.7 \text{ V to } 5.5 \text{ V}$, $AV_{CC} = 2.7 \text{ V to } 5.5 \text{ V}$, $V_{REF} = 2.7 \text{ V to } AV_{CC}$,
 $V_{SS} = AV_{SS} = 0 \text{ V}$, $\phi = 2 \text{ MHz to } 8 \text{ MHz}$, $T_a = -20^\circ\text{C to } +75^\circ\text{C}$ (regular specifications), $T_a = -40^\circ\text{C to } +85^\circ\text{C}$ (wide-range specifications)

Condition B: $V_{CC} = 3.0 \text{ V to } 5.5 \text{ V}$, $AV_{CC} = 3.0 \text{ V to } 5.5 \text{ V}$, $V_{REF} = 3.0 \text{ V to } AV_{CC}$,
 $V_{SS} = AV_{SS} = 0 \text{ V}$, $\phi = 2 \text{ MHz to } 10 \text{ MHz}$, $T_a = -20^\circ\text{C to } +75^\circ\text{C}$ (regular specifications), $T_a = -40^\circ\text{C to } +85^\circ\text{C}$ (wide-range specifications)

Condition C: $V_{CC} = 5.0 \text{ V} \pm 10\%$, $AV_{CC} = 5.0 \text{ V} \pm 10\%$, $V_{REF} = 4.5 \text{ V to } AV_{CC}$,
 $V_{SS} = AV_{SS} = 0 \text{ V}$, $\phi = 2 \text{ MHz to } 16 \text{ MHz}$, $T_a = -20^\circ\text{C to } +75^\circ\text{C}$ (regular specifications), $T_a = -40^\circ\text{C to } +85^\circ\text{C}$ (wide-range specifications)

Item	Condition A			Condition B			Condition C			Unit
	Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
Resolution	10	10	10	10	10	10	10	10	10	bits
Conversion time	—	—	16.8	—	—	13.4	—	—	8.4	μs
Analog input capacitance	—	—	20	—	—	20	—	—	20	pF
Permissible signal-source impedance	—	—	10^{*1}	—	—	10^{*1}	—	—	10^{*3}	kΩ
	—	—	5^{*2}			5^{*5}	—	—	5^{*4}	
Nonlinearity error	—	—	± 6.0	—	—	± 6.0	—	—	± 3.0	LSB
Offset error	—	—	± 4.0	—	—	± 4.0	—	—	± 2.0	LSB
Full-scale error	—	—	± 4.0	—	—	± 4.0	—	—	± 2.0	LSB
Quantization error	—	—	± 0.5	—	—	± 0.5	—	—	± 0.5	LSB
Absolute accuracy	—	—	± 8.0	—	—	± 8.0	—	—	± 4.0	LSB

- Notes:
1. The value is for $4.0 \leq AV_{CC} \leq 5.5$.
 2. The value is for $2.7 \leq AV_{CC} < 4.0$.
 3. The value is for $\phi \leq 12 \text{ MHz}$.
 4. The value is for $\phi > 12 \text{ MHz}$.
 5. The value is for $3.0 \leq AV_{CC} < 4.0$

18.3 Operational Timing

This section shows timing diagrams.

18.3.1 Bus Timing

Bus timing is shown as follows:

- Basic bus cycle: two-state access

Figure 18-4 shows the timing of the external two-state access cycle.

- Basic bus cycle: three-state access

Figure 18-5 shows the timing of the external three-state access cycle.

- Basic bus cycle: three-state access with one wait state

Figure 18-6 shows the timing of the external three-state access cycle with one wait state inserted.

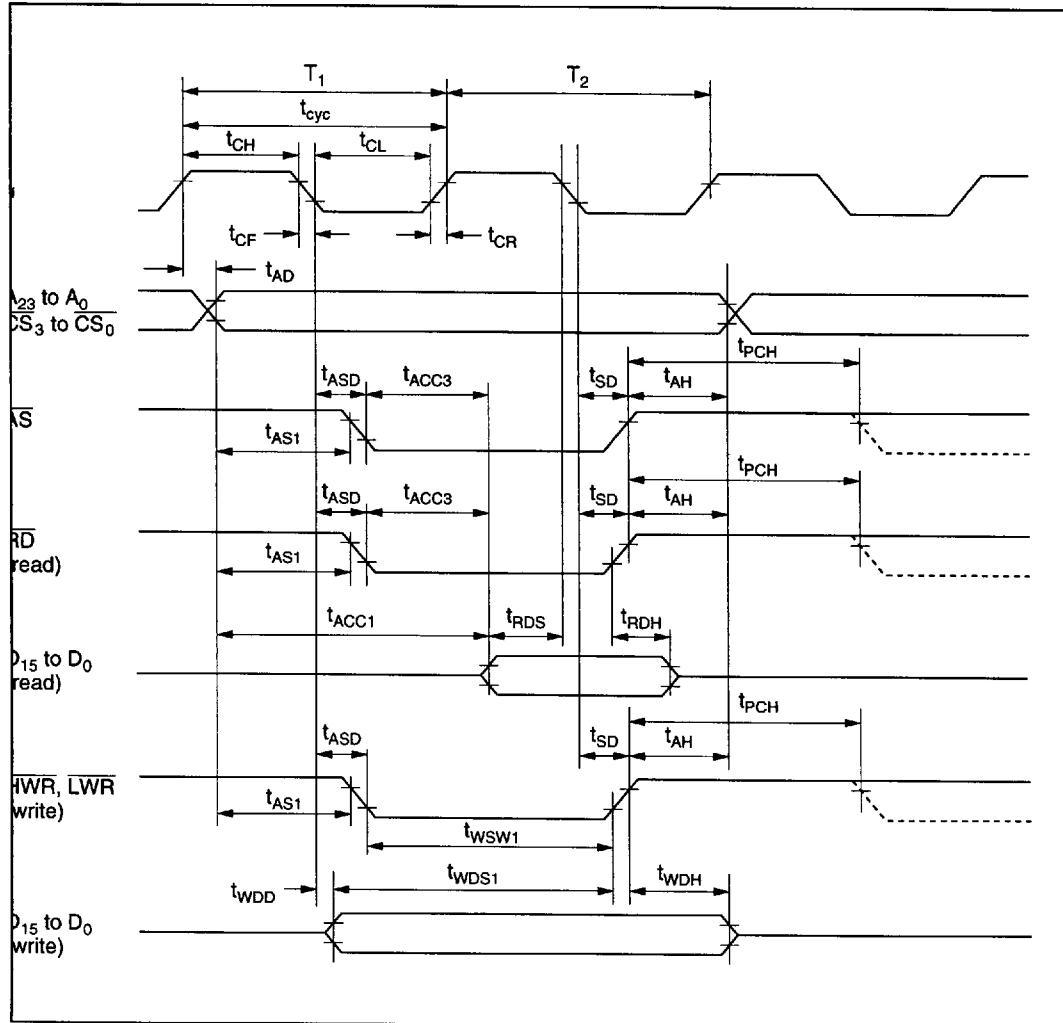


Figure 18-4 Basic Bus Cycle: Two-State Access

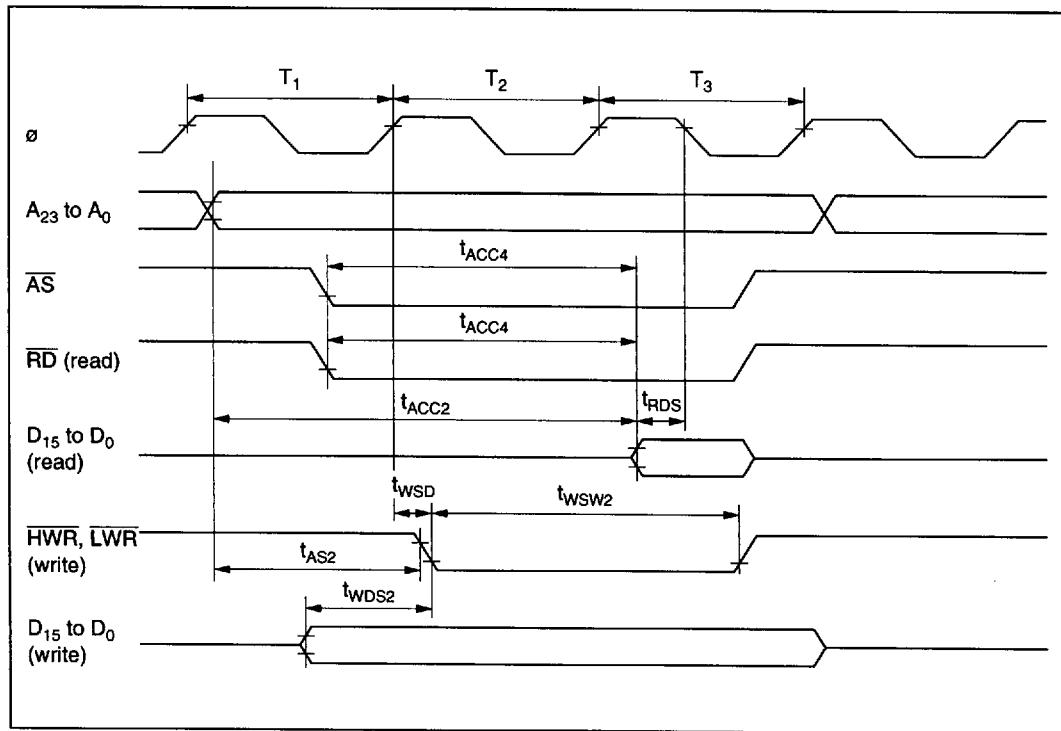


Figure 18-5 Basic Bus Cycle: Three-State Access

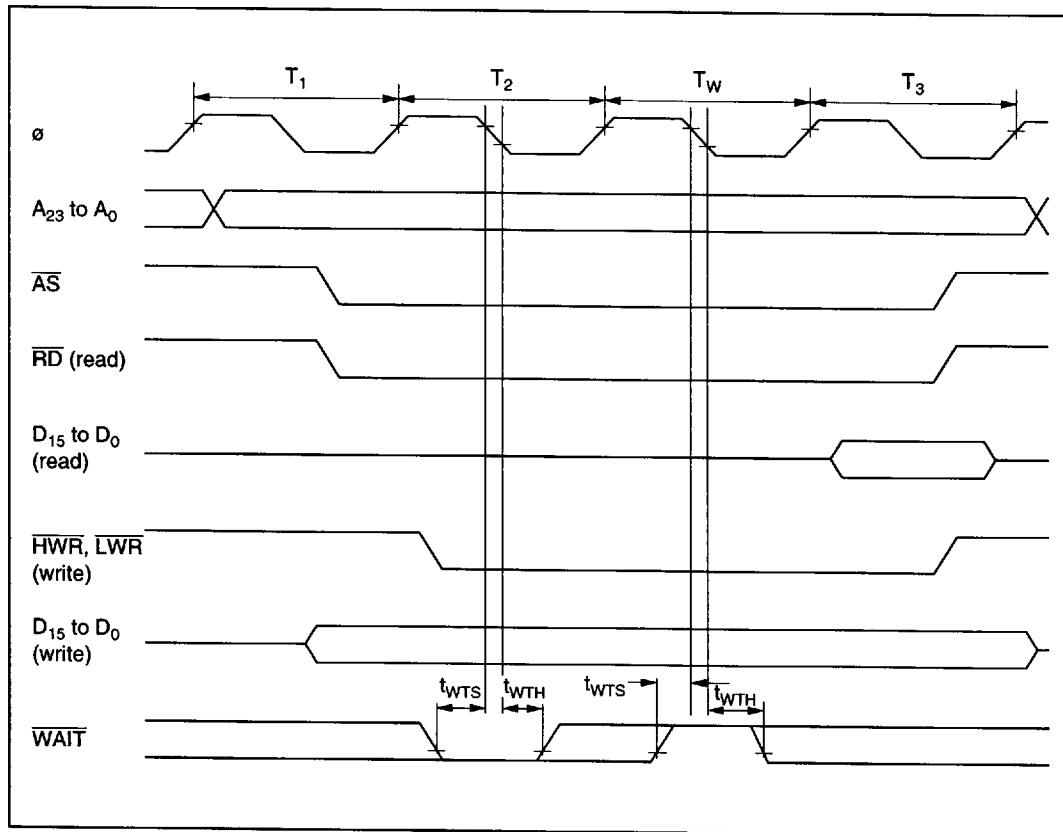


Figure 18-6 Basic Bus Cycle: Three-State Access with One Wait State

18.3.2 Refresh Controller Bus Timing

Refresh controller bus timing is shown as follows:

- DRAM bus timing

Figures 18-7 to 18-12 show the DRAM bus timing in each operating mode.

- PSRAM bus timing

Figures 18-13 and 18-14 show the pseudo-static RAM bus timing in each operating mode.

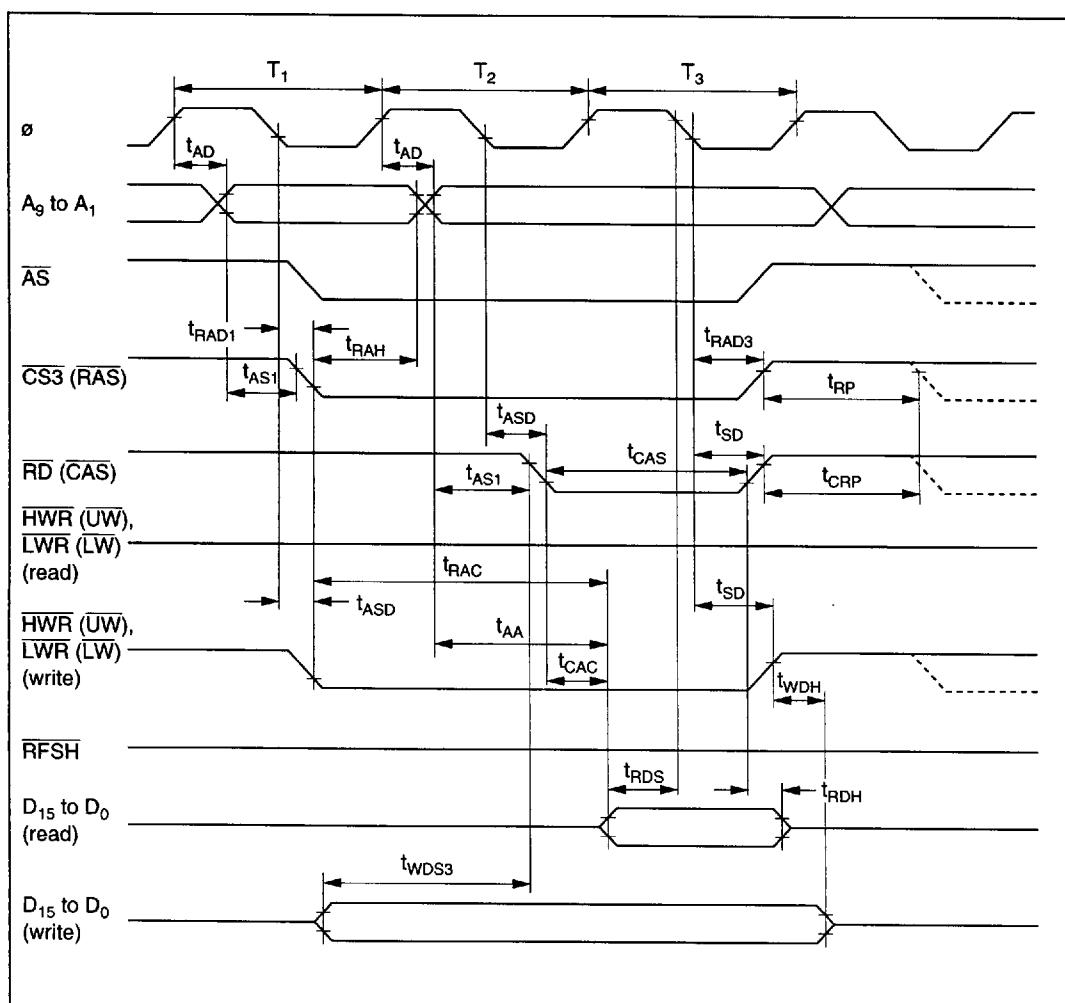


Figure 18-7 DRAM Bus Timing (Read/Write): Three-State Access

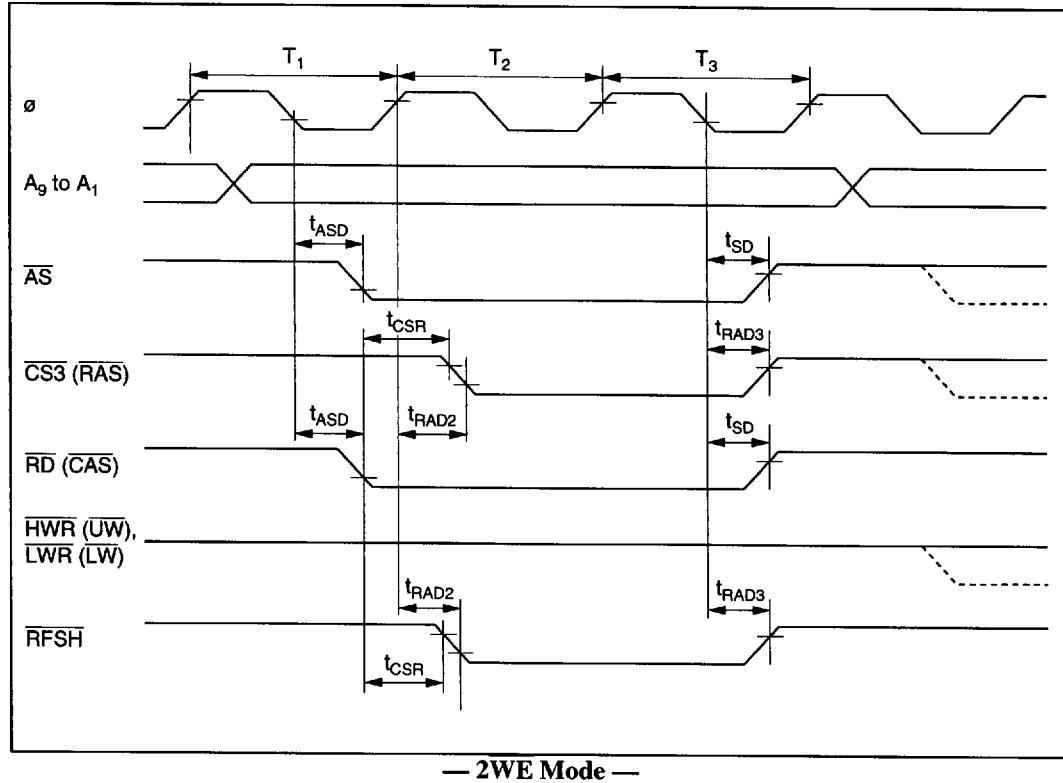


Figure 18-8 DRAM Bus Timing (Refresh Cycle): Three-State Access

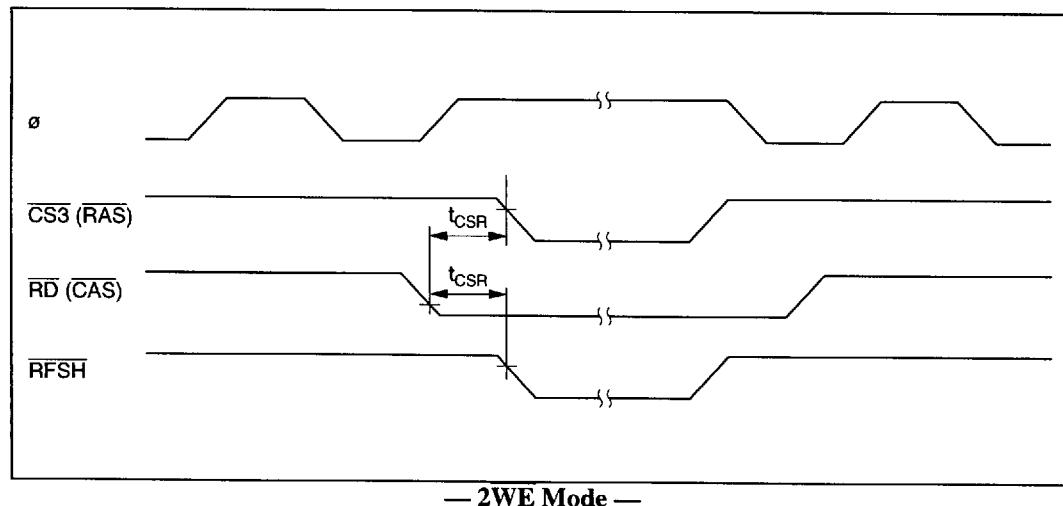
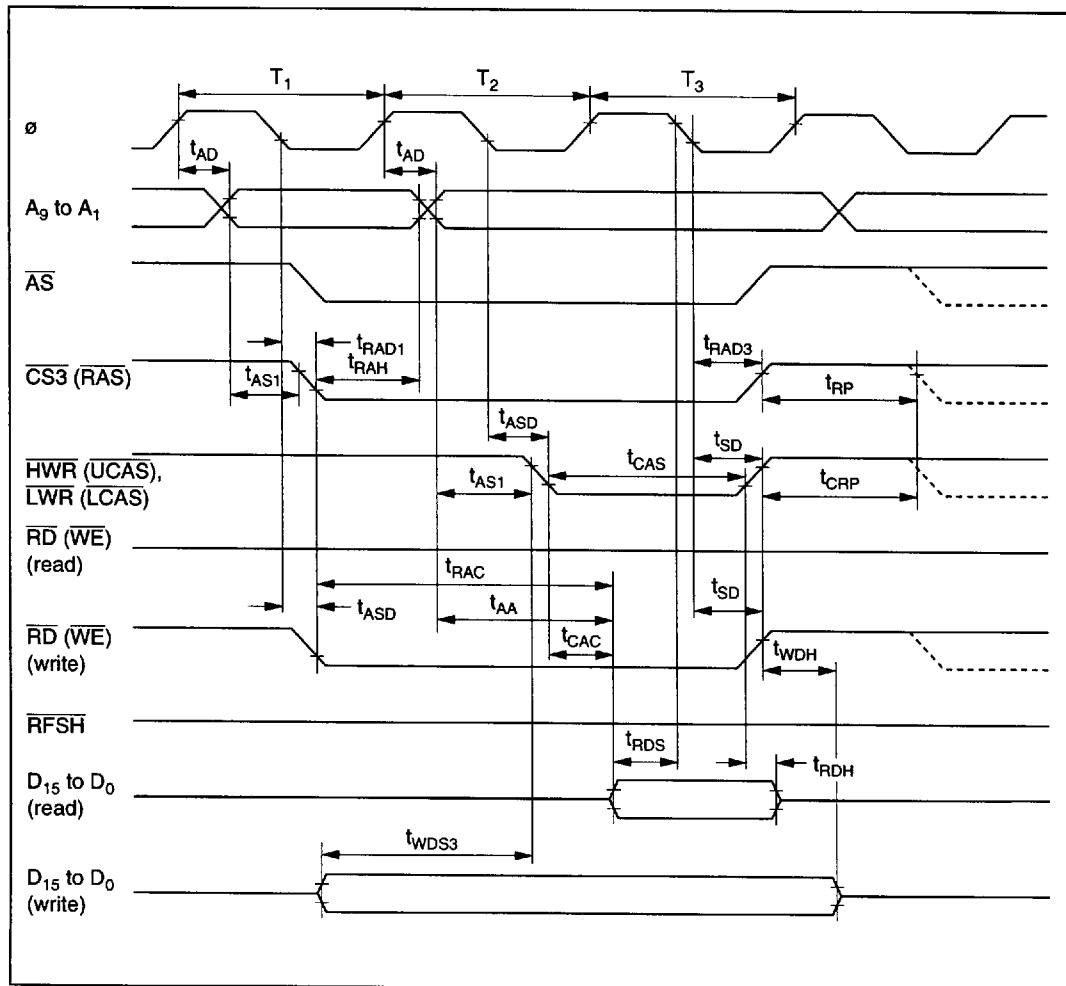


Figure 18-9 DRAM Bus Timing (Self-Refresh Mode)



— 2WE Mode —

Figure 18-10 DRAM Bus Timing (Read/Write): Three-State Access
— 2CAS Mode —

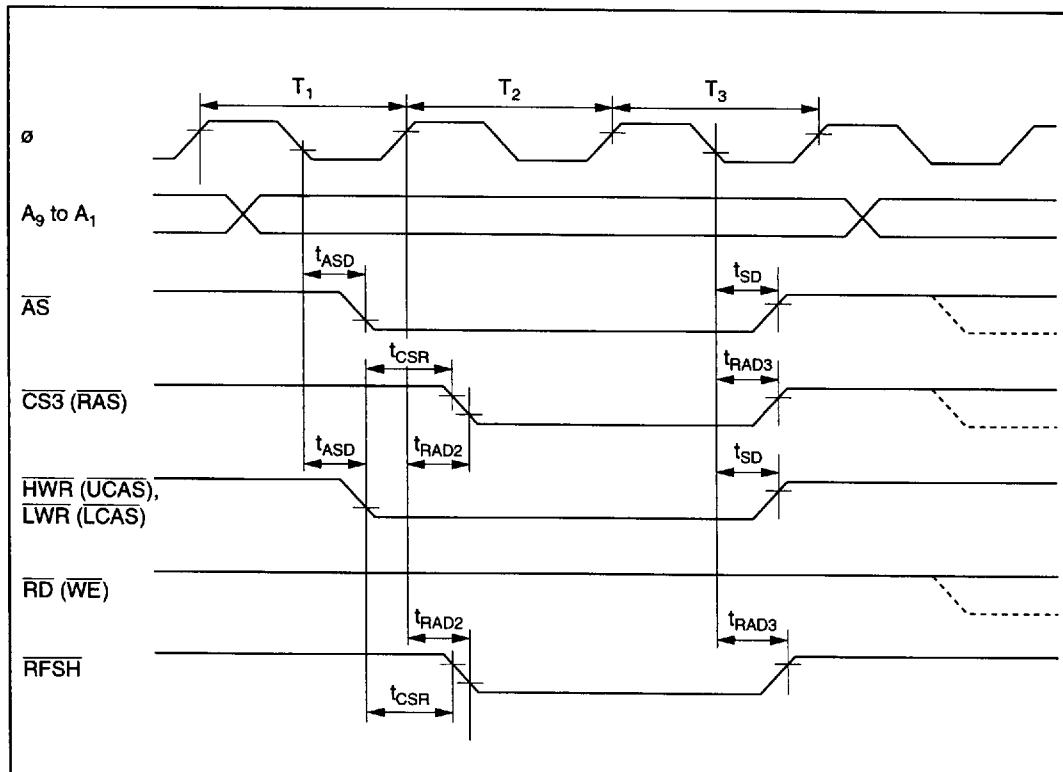


Figure 18-11 DRAM Bus Timing (Refresh Cycle): Three-State Access
—2CAS Mode—

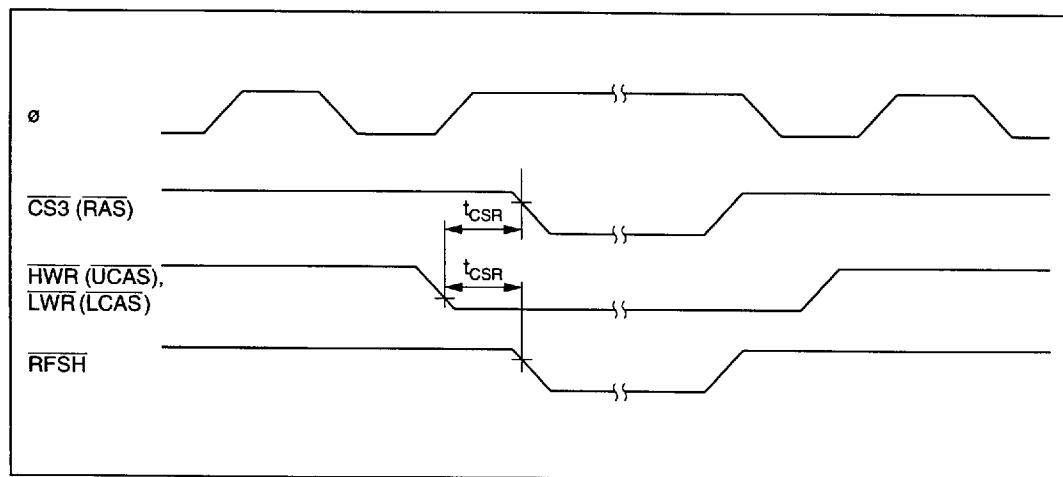


Figure 18-12 DRAM Bus Timing (Self-Refresh Mode)
—2CAS Mode—

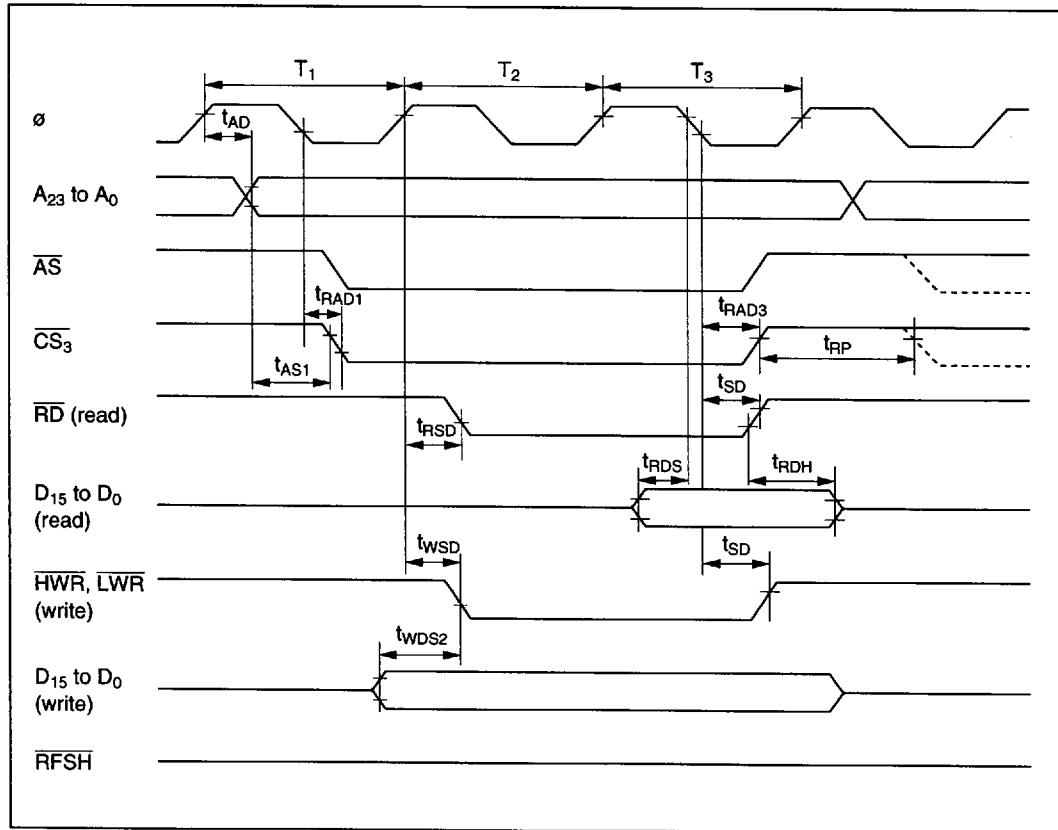


Figure 18-13 PSRAM Bus Timing (Read/Write): Three-State Access

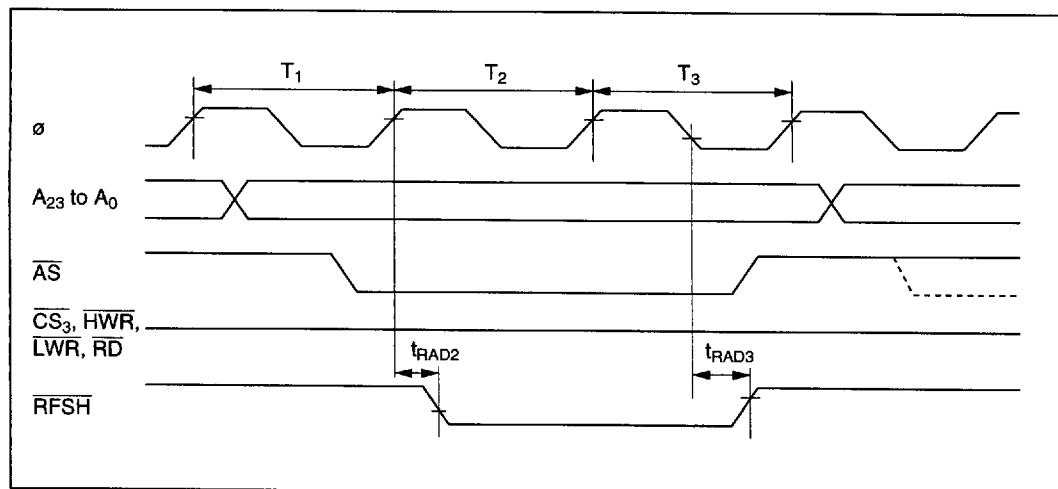


Figure 18-14 PSRAM Bus Timing (Refresh Cycle): Three-State Access

18.3.3 Control Signal Timing

Control signal timing is shown as follows:

- Reset input timing

Figure 18-15 shows the reset input timing.

- Reset output timing

Figure 18-16 shows the reset output timing.

- Interrupt input timing

Figure 18-17 shows the input timing for NMI and $\overline{IRQ_5}$ to $\overline{IRQ_0}$.

- Bus-release mode timing

Figure 18-18 shows the bus-release mode timing.

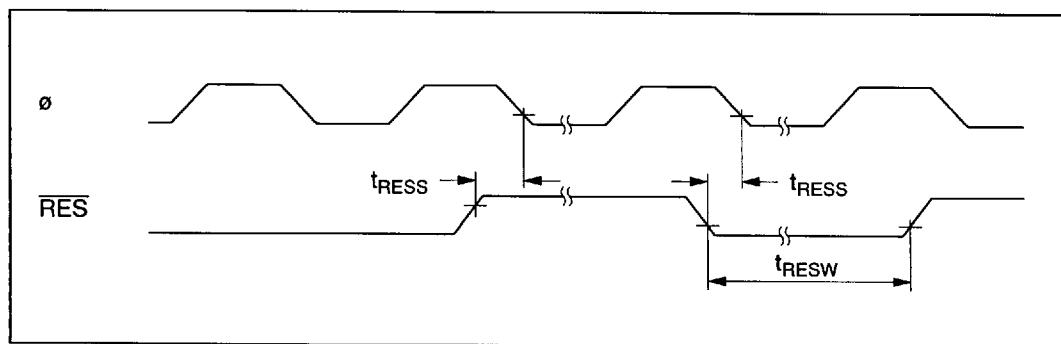


Figure 18-15 Reset Input Timing

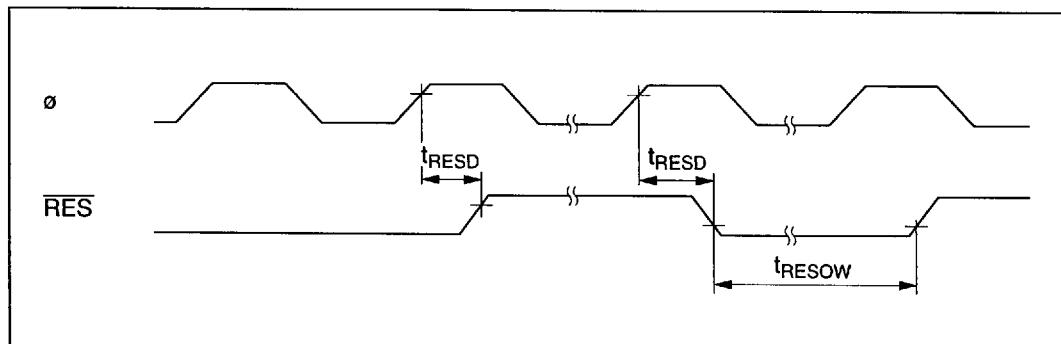


Figure 18-16 Reset Output Timing

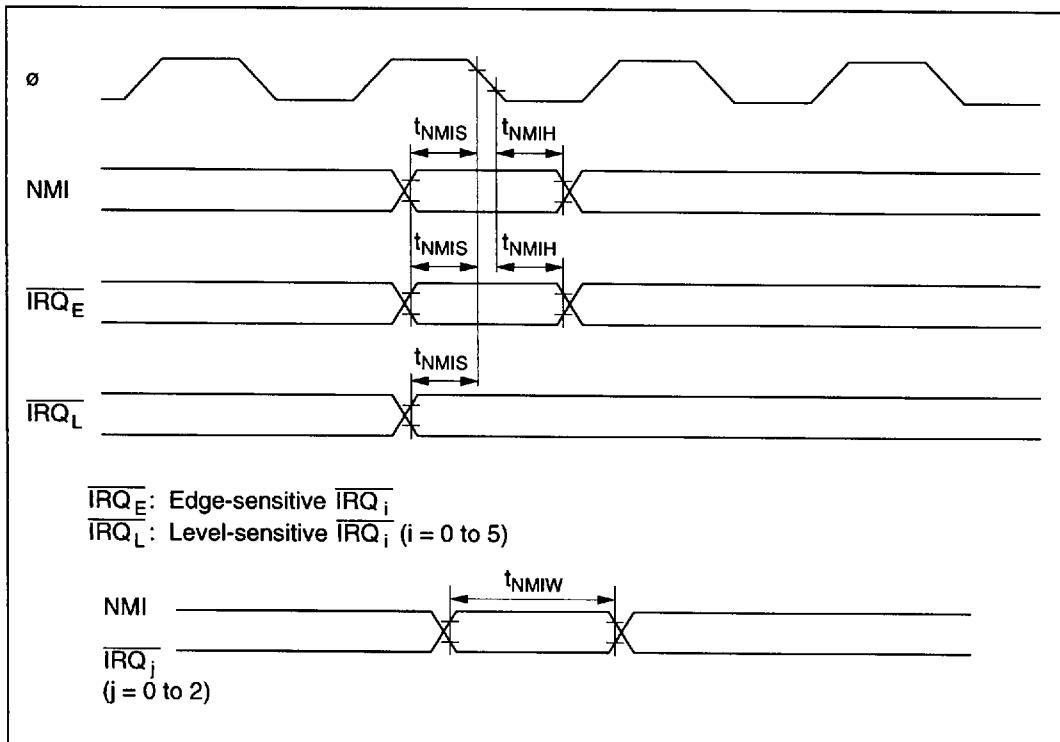


Figure 18-17 Interrupt Input Timing

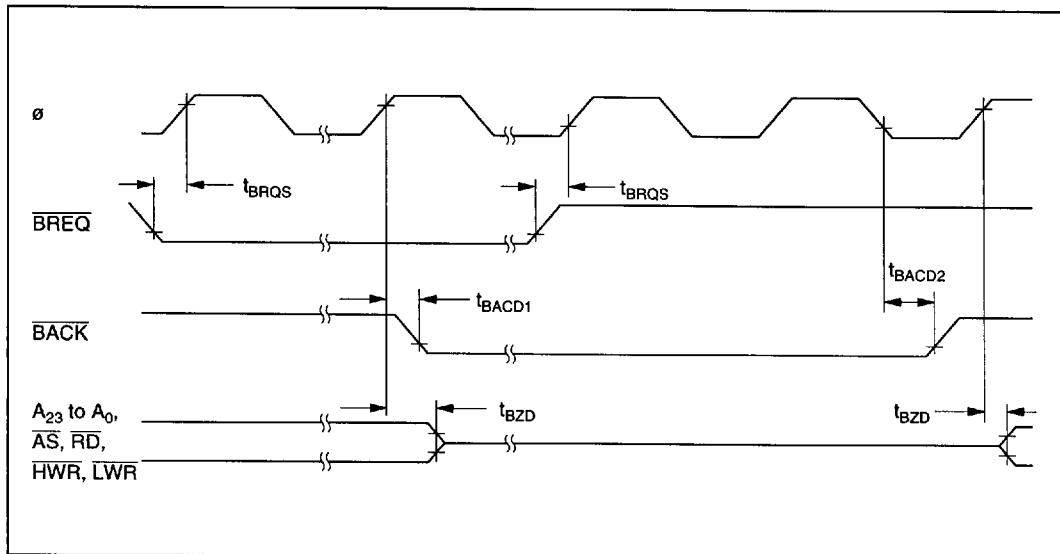


Figure 18-18 Bus-Release Mode Timing

18.3.4 Clock Timing

Clock timing is shown as follows:

- Oscillator settling timing

Figure 18-19 shows the oscillator settling timing.

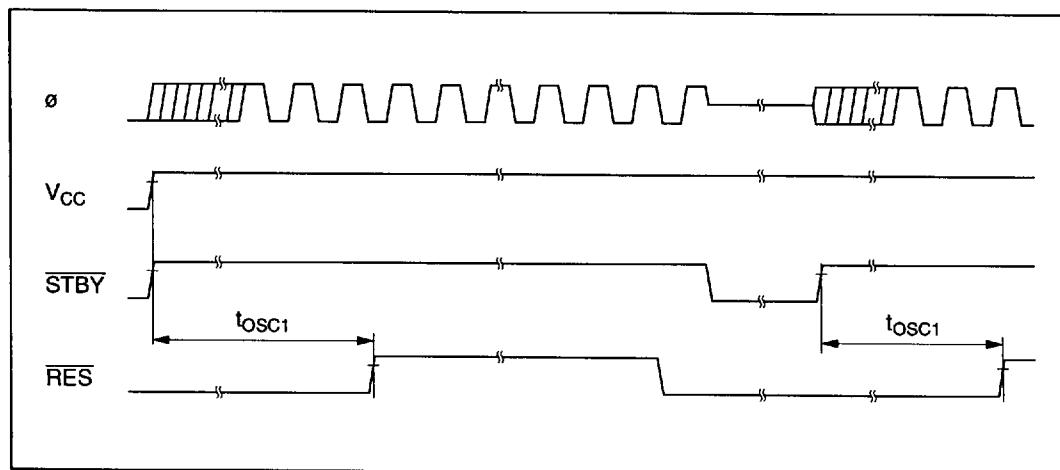


Figure 18-19 Oscillator Settling Timing

18.3.5 TPC and I/O Port Timing

TPC and I/O port timing is shown as follows.

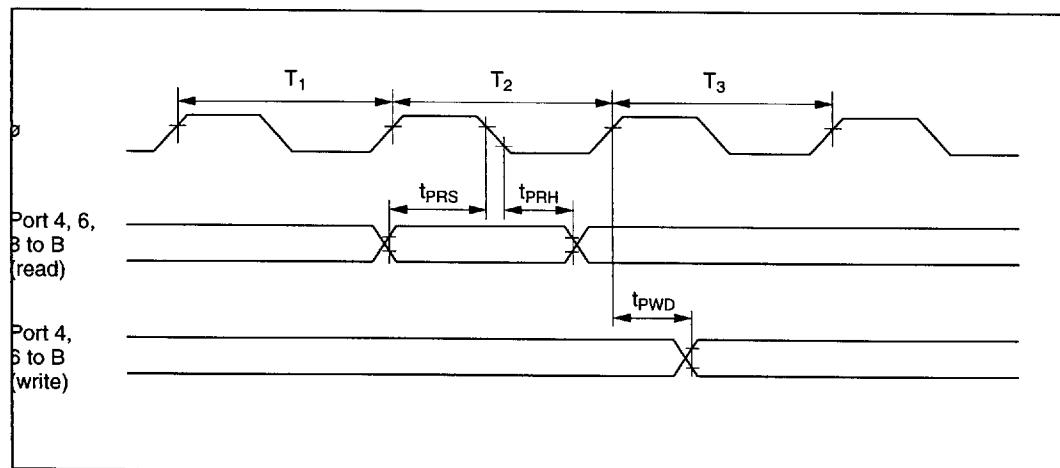


Figure 18-20 TPC and I/O Port Input/Output Timing

18.3.6 ITU Timing

ITU timing is shown as follows:

- ITU input/output timing

Figure 18-21 shows the ITU input/output timing.

- ITU external clock input timing

Figure 18-22 shows the ITU external clock input timing.

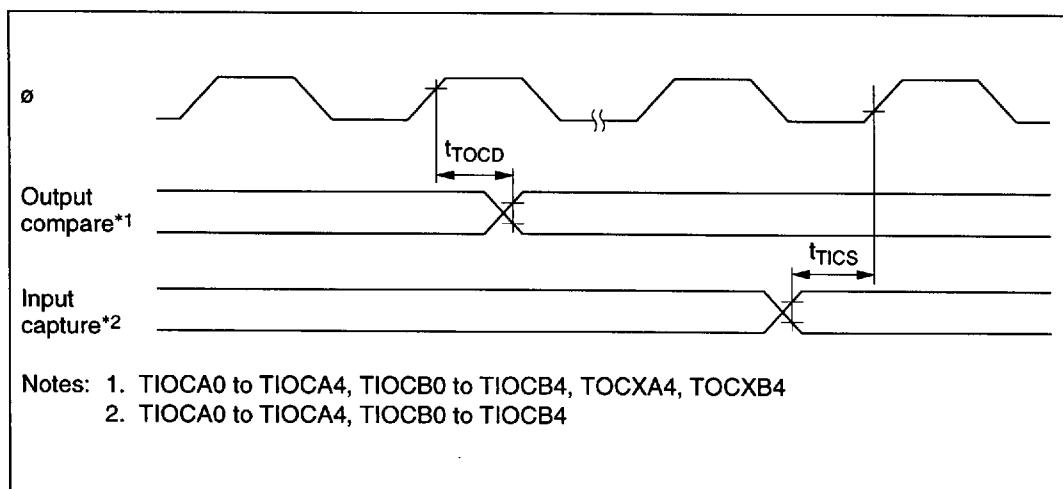


Figure 18-21 ITU Input/Output Timing

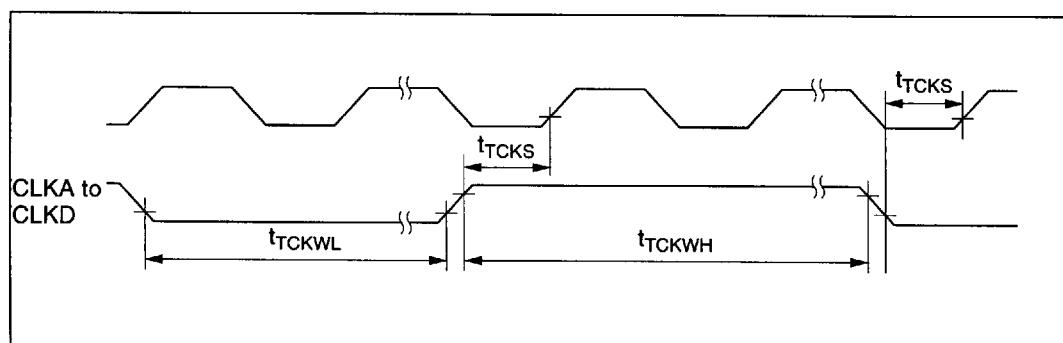


Figure 18-22 ITU Clock Input Timing

18.3.7 SCI Input/Output Timing

SCI timing is shown as follows:

- SCI input clock timing

Figure 18-23 shows the SCI input clock timing.

- SCI input/output timing (synchronous mode)

Figure 18-24 shows the SCI input/output timing in synchronous mode.

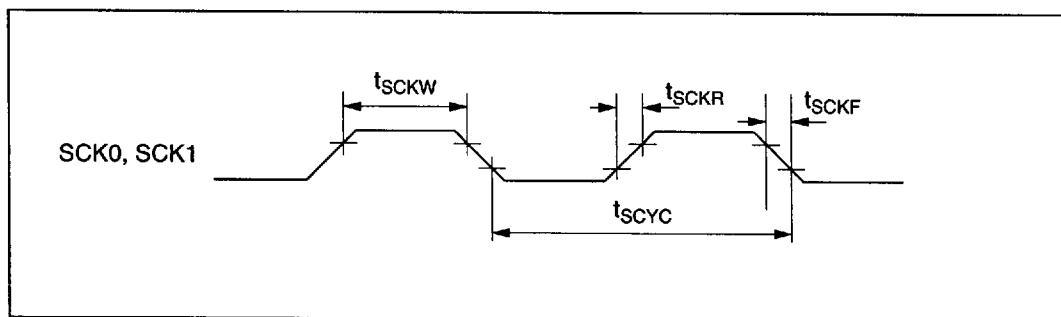


Figure 18-23 SCI Input Clock Timing

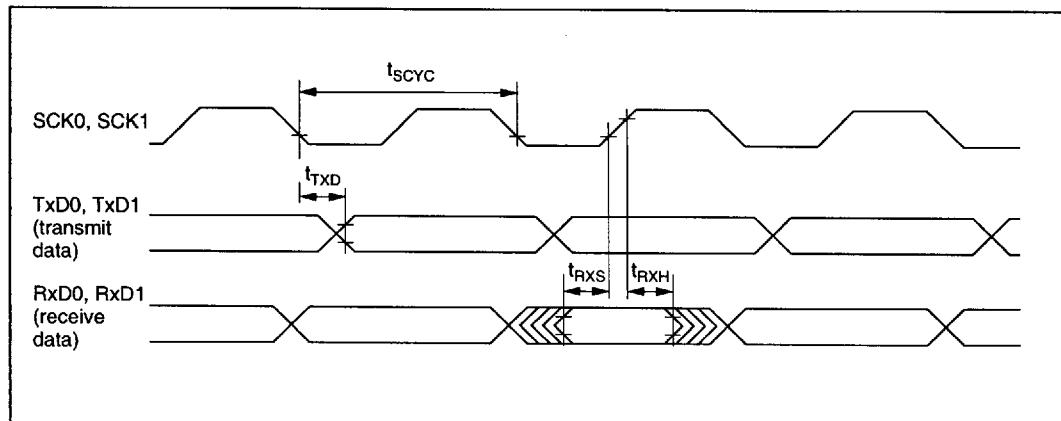


Figure 18-24 SCI Input/Output Timing in Synchronous Mode

18.3.8 DMAC Timing

DMAC timing is shown as follows.

- DMAC $\overline{\text{TEND}}$ output timing for 2 state access

Figure 18-25 shows the DMAC $\overline{\text{TEND}}$ output timing for 2 state access.

- DMAC $\overline{\text{TEND}}$ output timing for 3 state access

Figure 18-26 shows the DMAC $\overline{\text{TEND}}$ output timing for 3 state access.

- DMAC $\overline{\text{DREQ}}$ input timing

Figure 18-27 shows DMAC $\overline{\text{DREQ}}$ input timing.

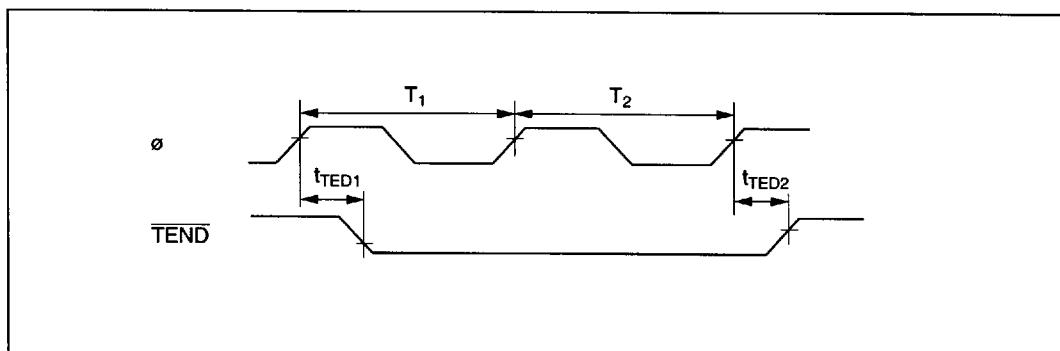


Figure 18-25 DMAC $\overline{\text{TEND}}$ Output Timing/2 State Access

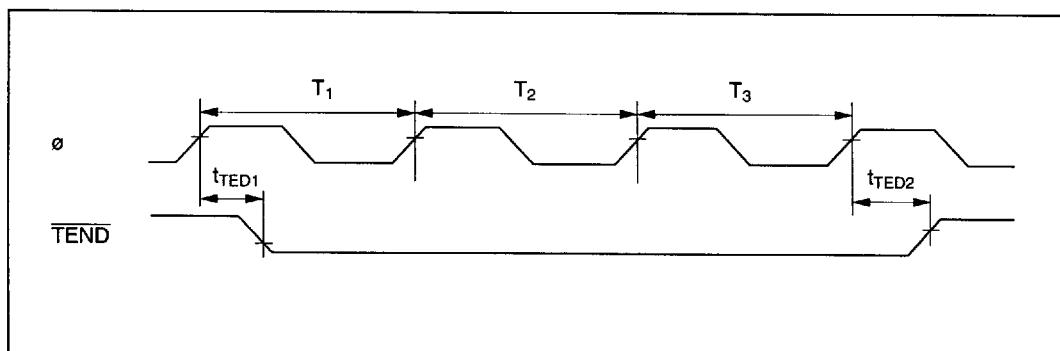


Figure 18-26 DMAC $\overline{\text{TEND}}$ Output Timing/3 State Access

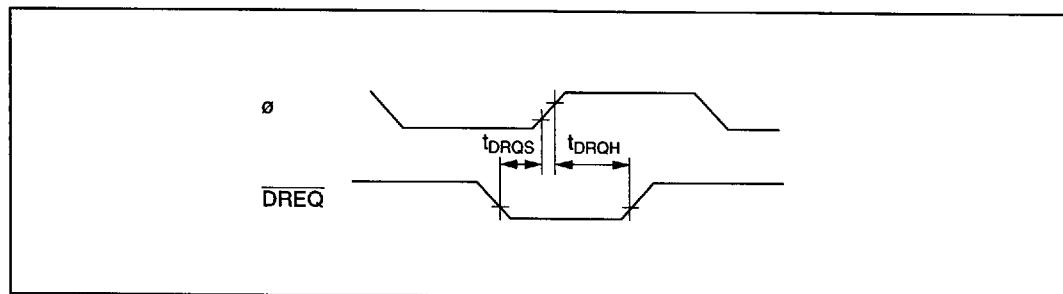


Figure 18-27 DMAC \overline{DREQ} Input Timing